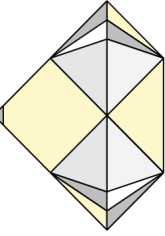
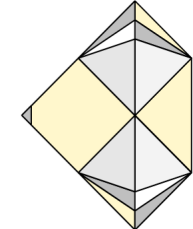


Diamond tracking detectors: present and future

Dmitry Hits on behalf of RD42 collaboration



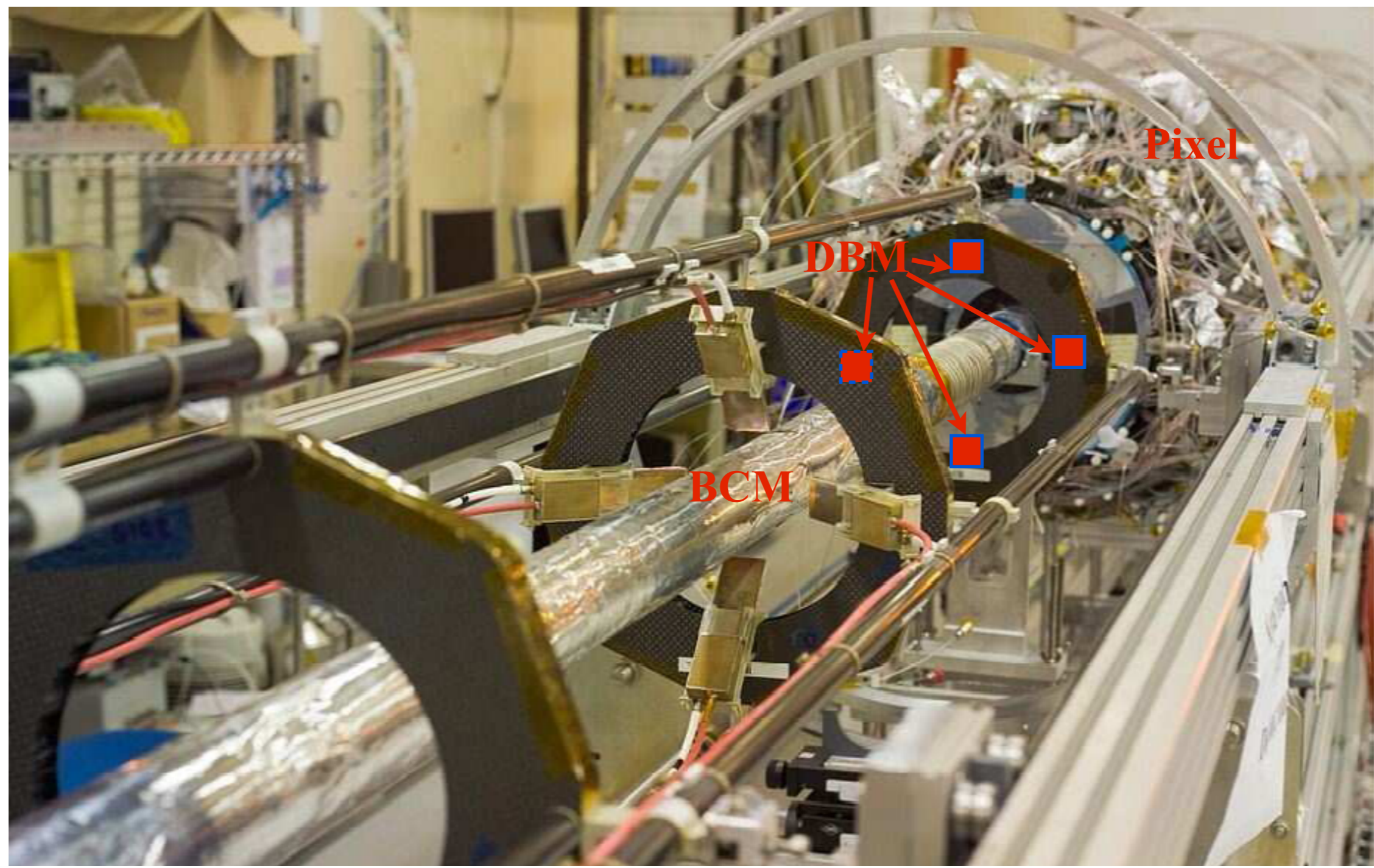
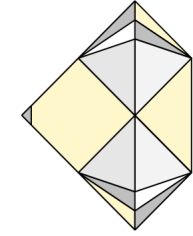
- ATLAS Diamond Beam Monitor (DBM)
 - Design
 - Construction
 - Selected preliminary performance results with pre-production modules
- Diamond 3D detector
 - Principle
 - Fabrication
 - Beam test results



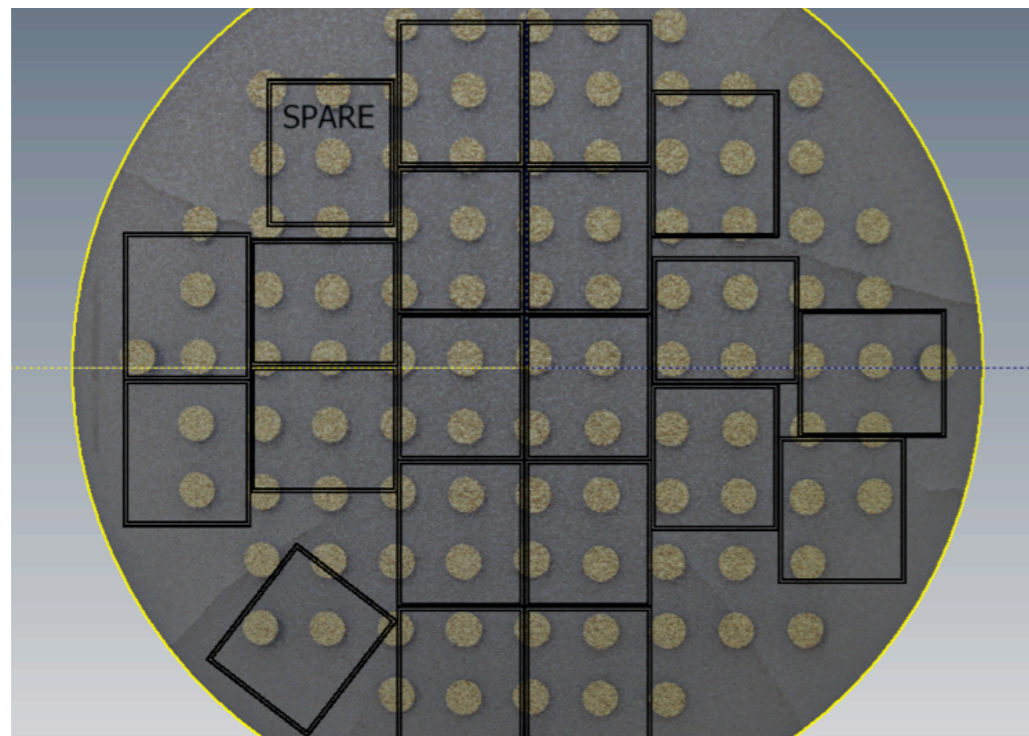
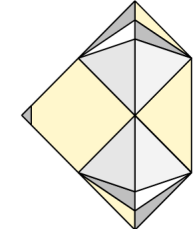
ATLAS DBM - purpose and specs

- Purpose
 - Bunch-by-bunch luminosity monitor (aim < 1 % per Bunch Crossing per Luminosity Segment)
 - ➔ Finer segmentation (~27k pixels !)
 - ➔ Never saturates
 - ➔ Internal stability monitoring by tracking
 - Bunch-by-bunch beam spot monitor
 - ➔ Need triple-module telescopes for (limited) tracking
 - ➔ Can distinguish hits from beam halo tracks
 - ➔ Unbiased sample, acceptance extends far along beam axis
- Design considerations
 - Baseline: four telescopes of 3 modules per side → 24 total
 - ➔ Design of the modules is identical to Insertable B-Layer (IBL) modules (the innermost pixel layer of ATLAS Detector)
 - Avoid IBL insertion volume and ID acceptance ($\eta > 2.5$)
 - Place in pixel support structure close to detector and beam pipe

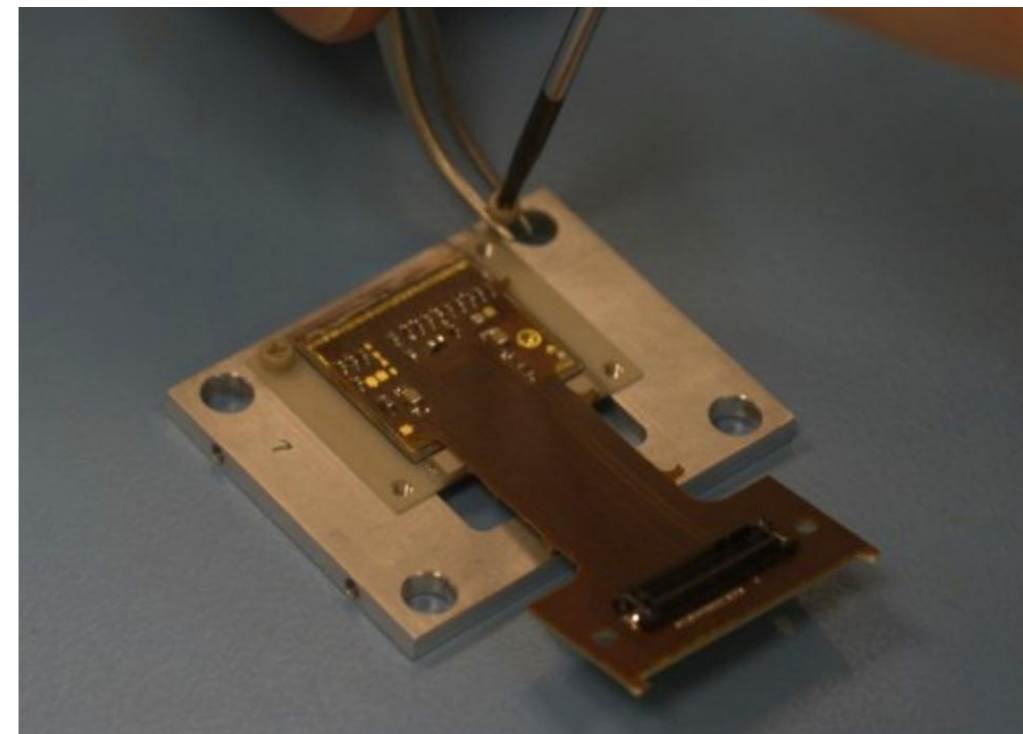
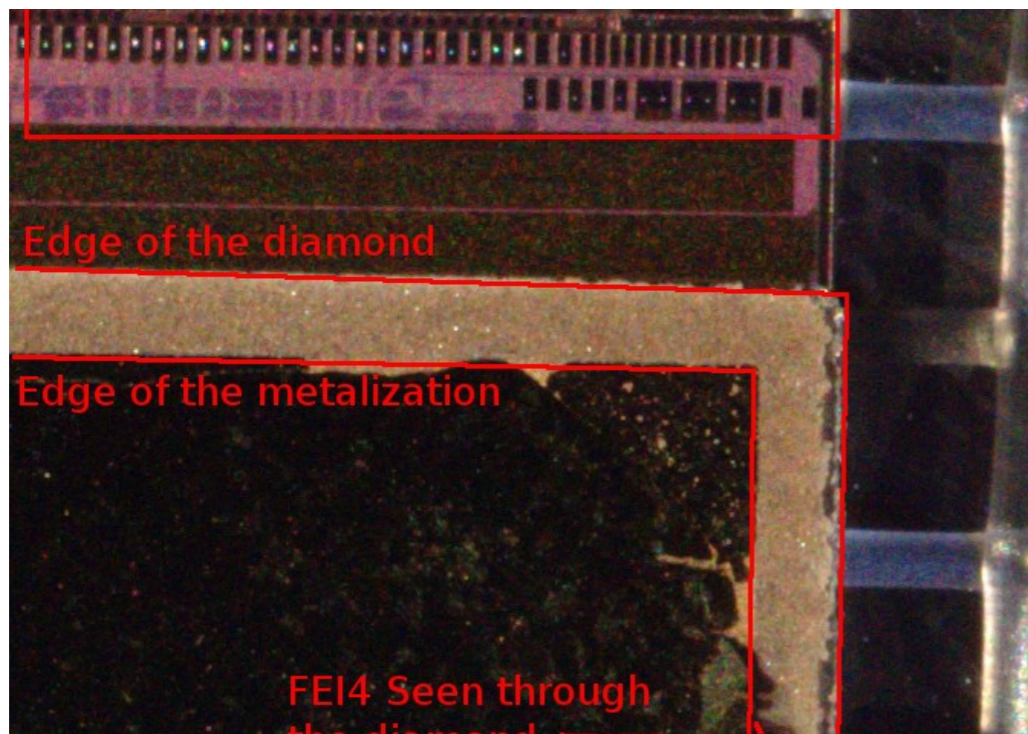
DBM Installation location

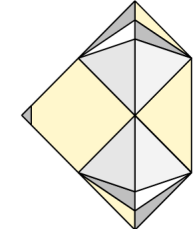


DBM production

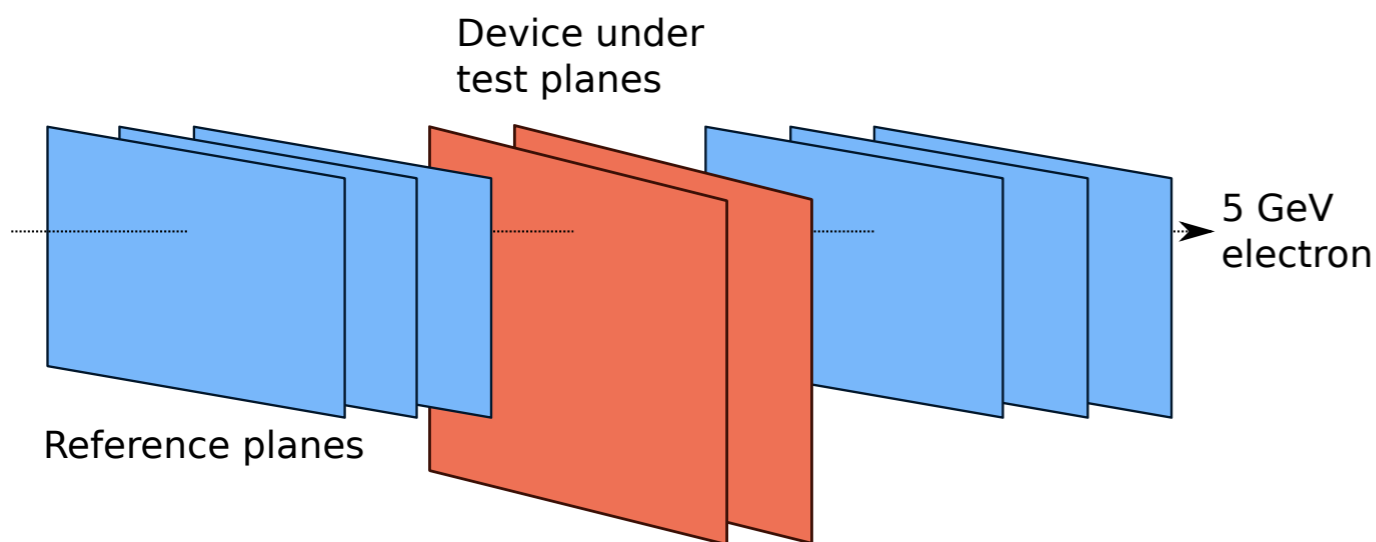
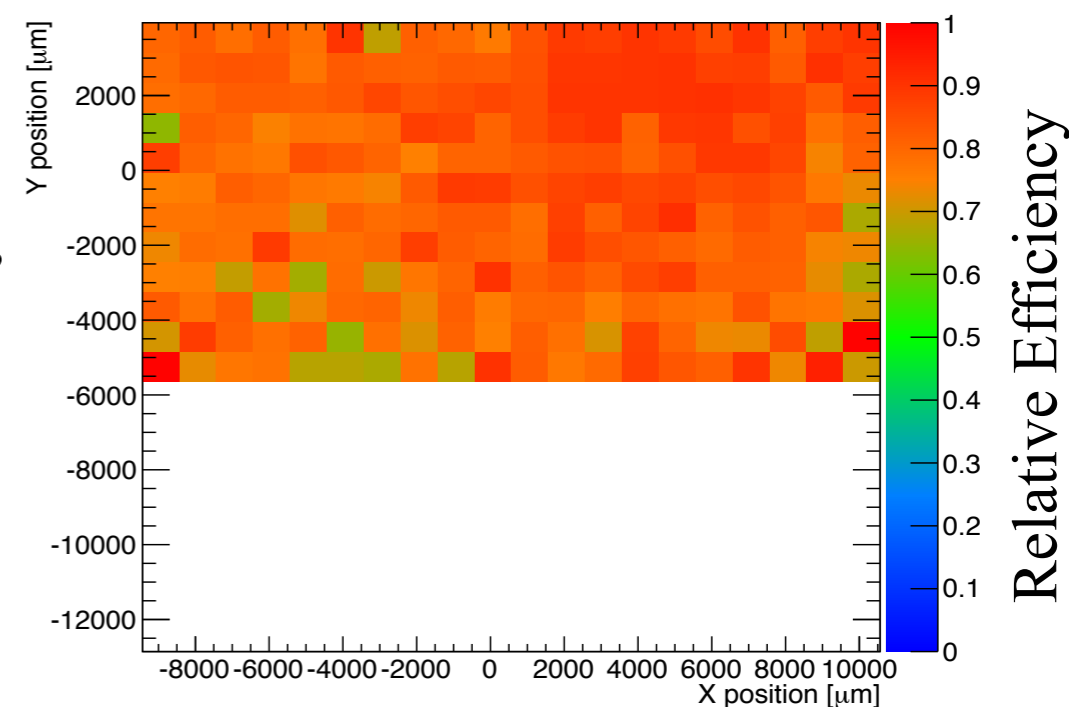


- 6 inch diamond wafer grown by II-VI infrared
 - Pieces from the wafer selected based on leakage current and collected charge
- pieces are cut out from the wafer and thinned down/polished by II-VI infrared
 - 18 mm x 21 mm x 0.5 mm polyCVD
- sensors are metallized by OSU and IZM
- bump bonded to FE-I4 chips by IZM
- assembled into modules at CERN.

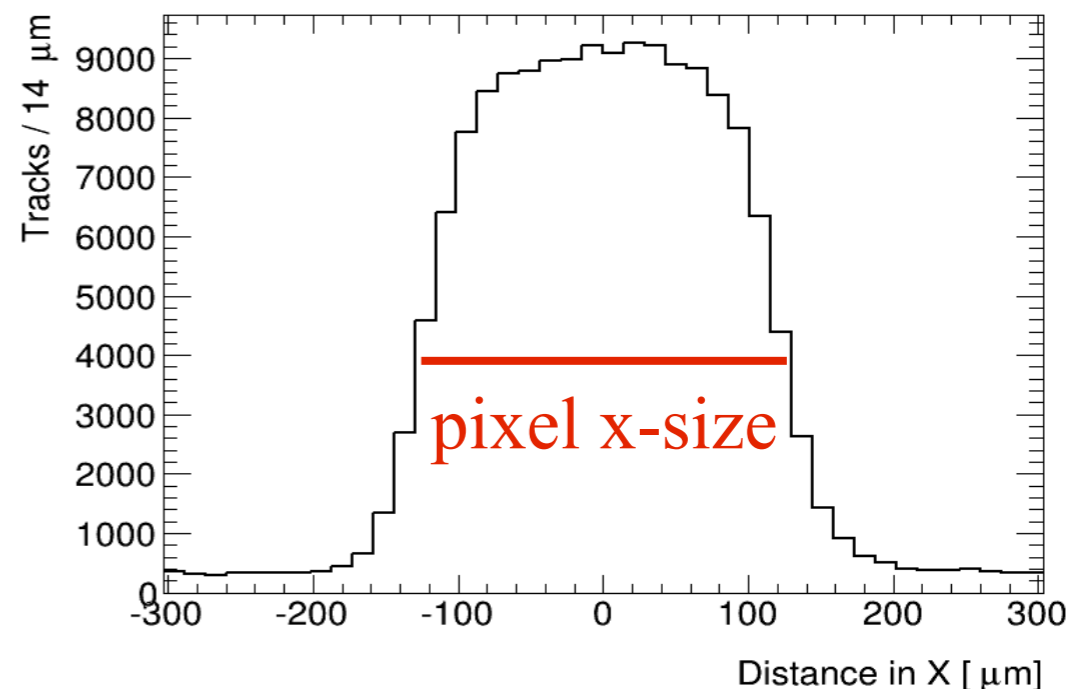


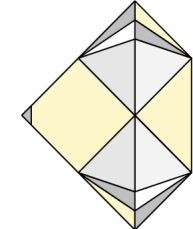


- Pre-production diamond planes bump bonded to FE-I4 chips
- Silicon sensor, also bump bonded to FE-I4 readout chip, was used as a reference plane
- Studied relative efficiency and resolution vs applied sensor bias and for several readout chip thresholds.
 - Bias: 660 V, 800 V, 1000 V
 - Threshold: 1100 e⁻, 1500 e⁻, 2000 e⁻, 2500 e⁻

MDBM-01, Threshold 1100 e⁻

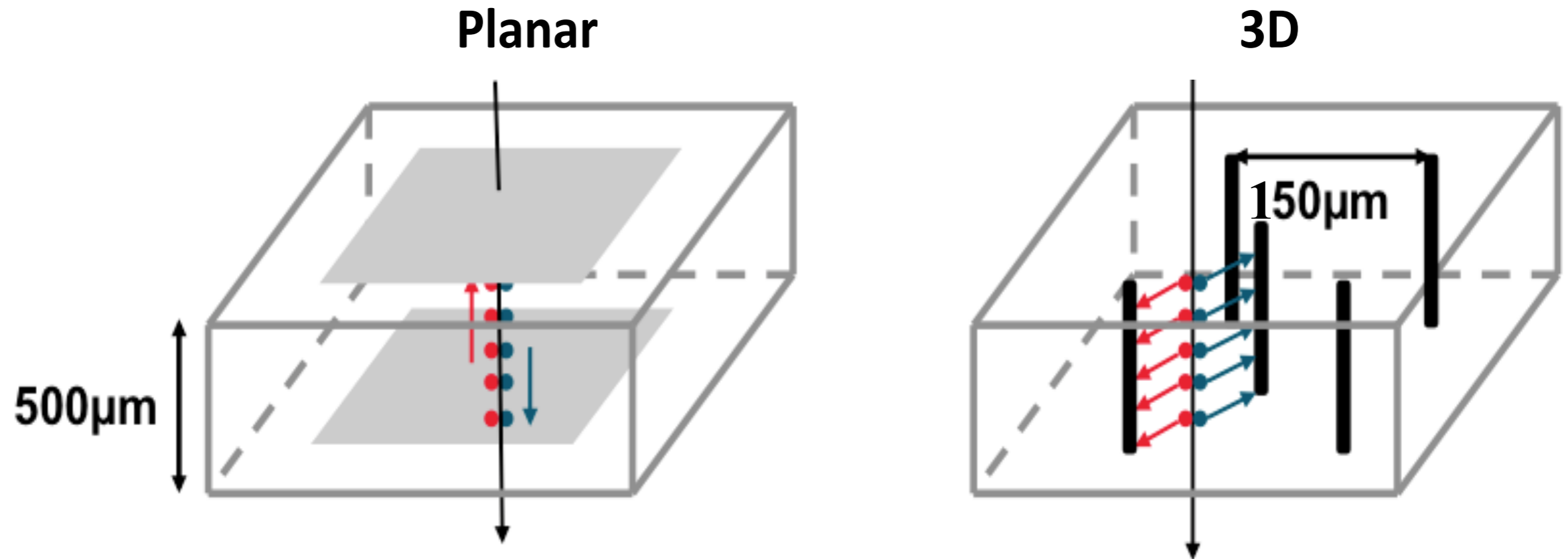
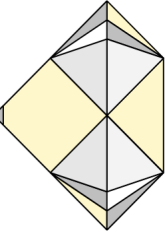
MDBM-01, X-residual





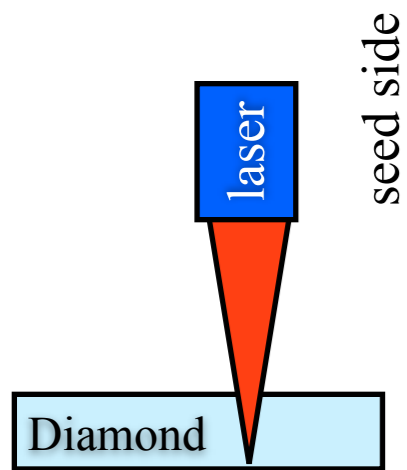
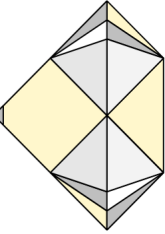
Diamond 3D devices

3D principle

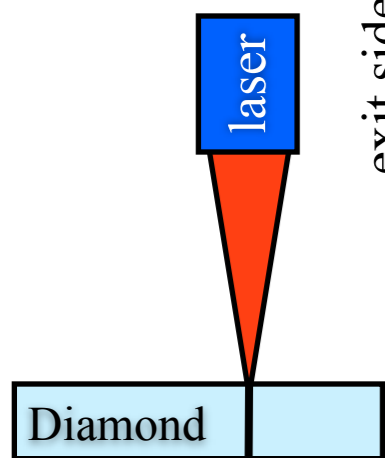
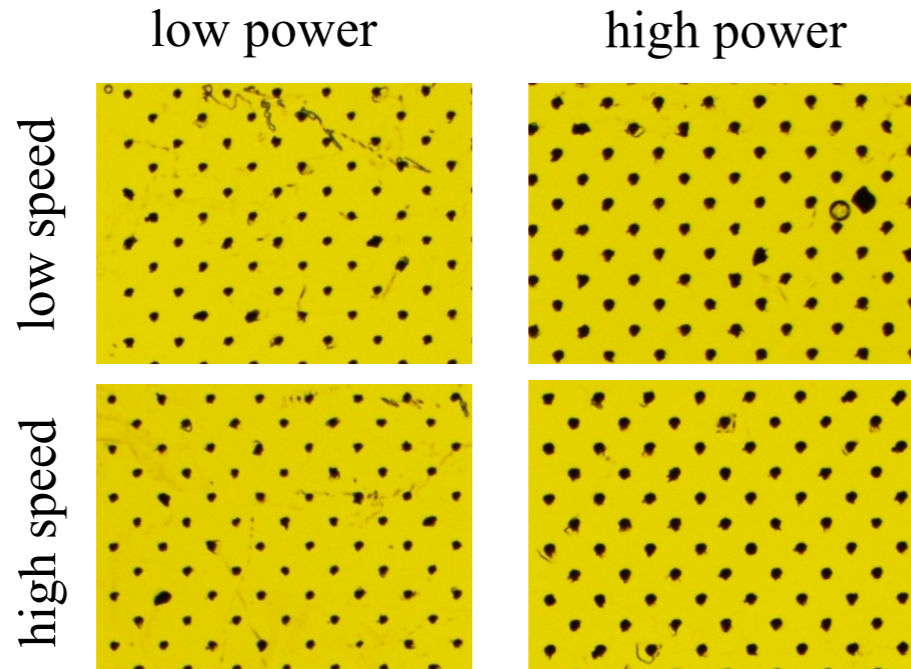


- Same amount of charge deposited by ionizing particle
- Drift distances shorter than in planar ($\approx 100\mu\text{m}$ vs. $500\mu\text{m}$)
 - Comparable to mean free path of charge carriers in irradiated diamond (few 10^{15} p/cm²)
 - More efficient charge collection

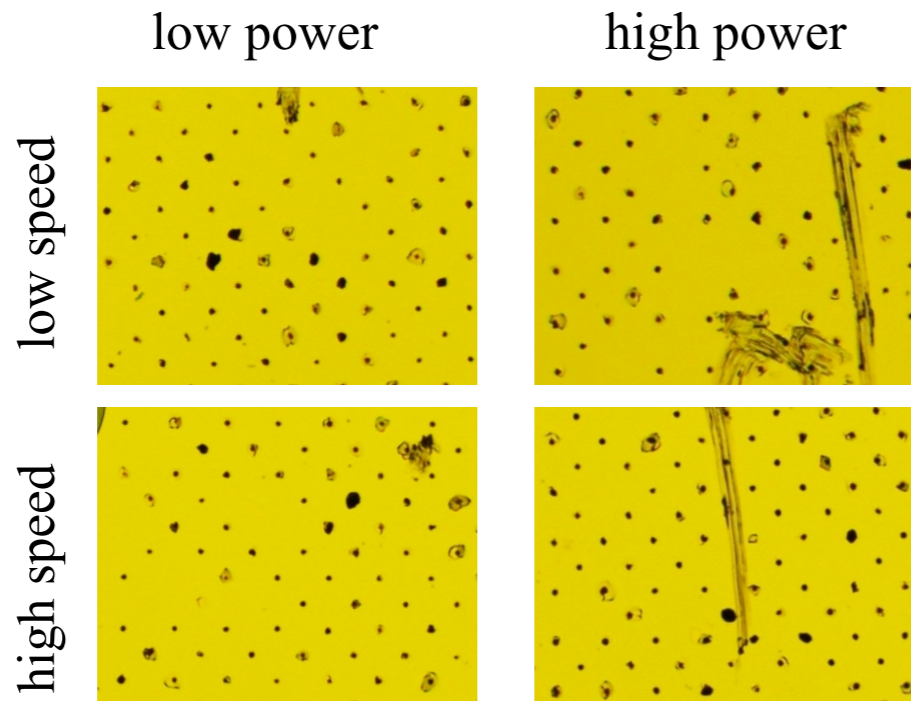
Drilling efficiency



seed side



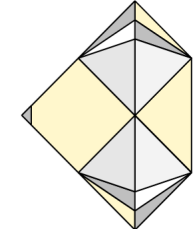
exit side



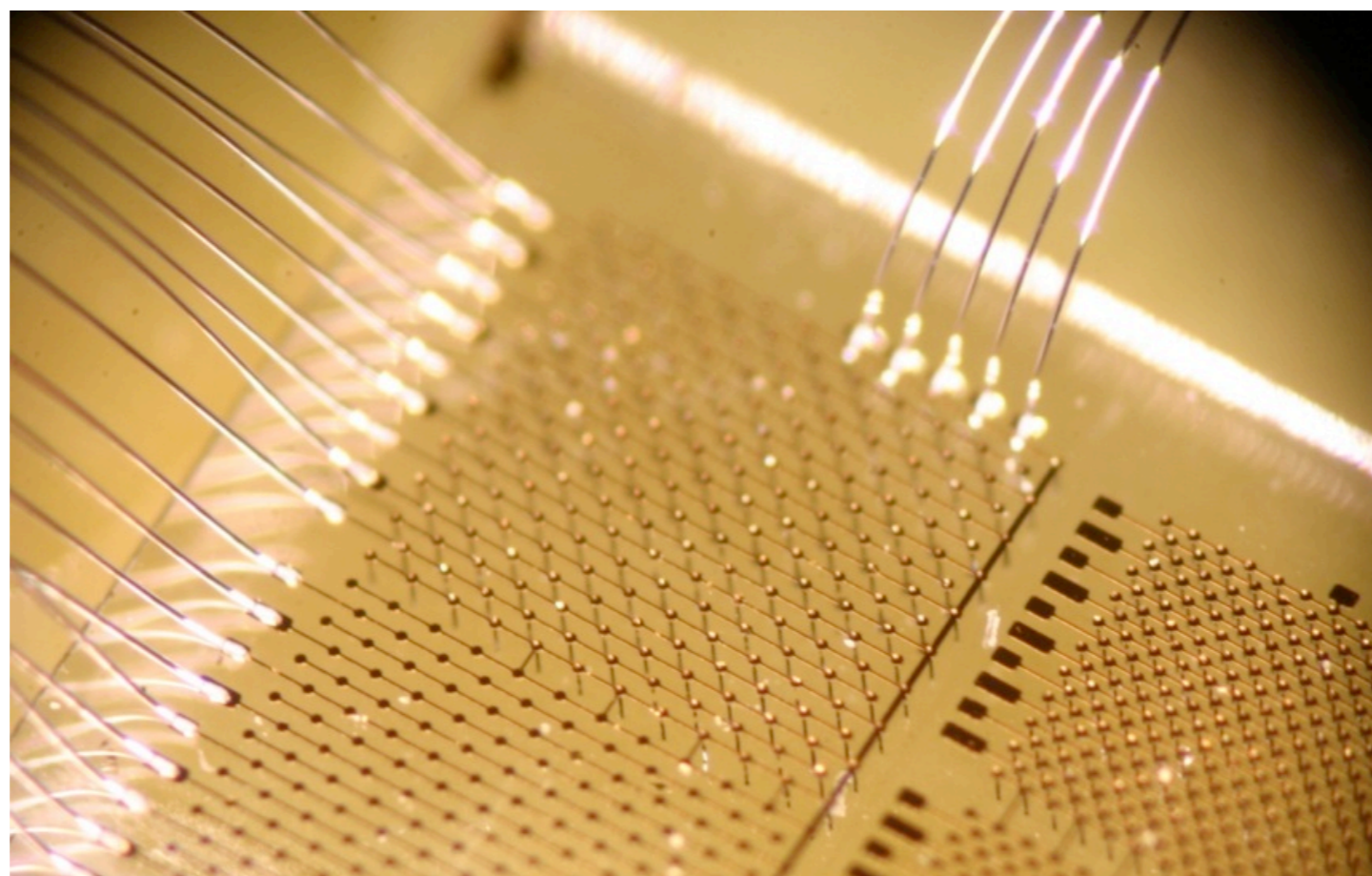
- “Drill” columns in diamond with 800 nm femtosecond laser
- Tried 4 different “drilling” parameter
 - best is to “drill” fast and with low power

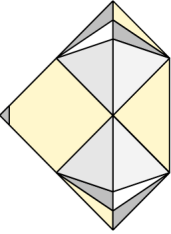
	low power	high power
low speed	92.2 ± 1.4 %	78.7 ± 2.1%
high speed	93.3 ± 1.3 %	87.6 ± 1.7 %

Metallization



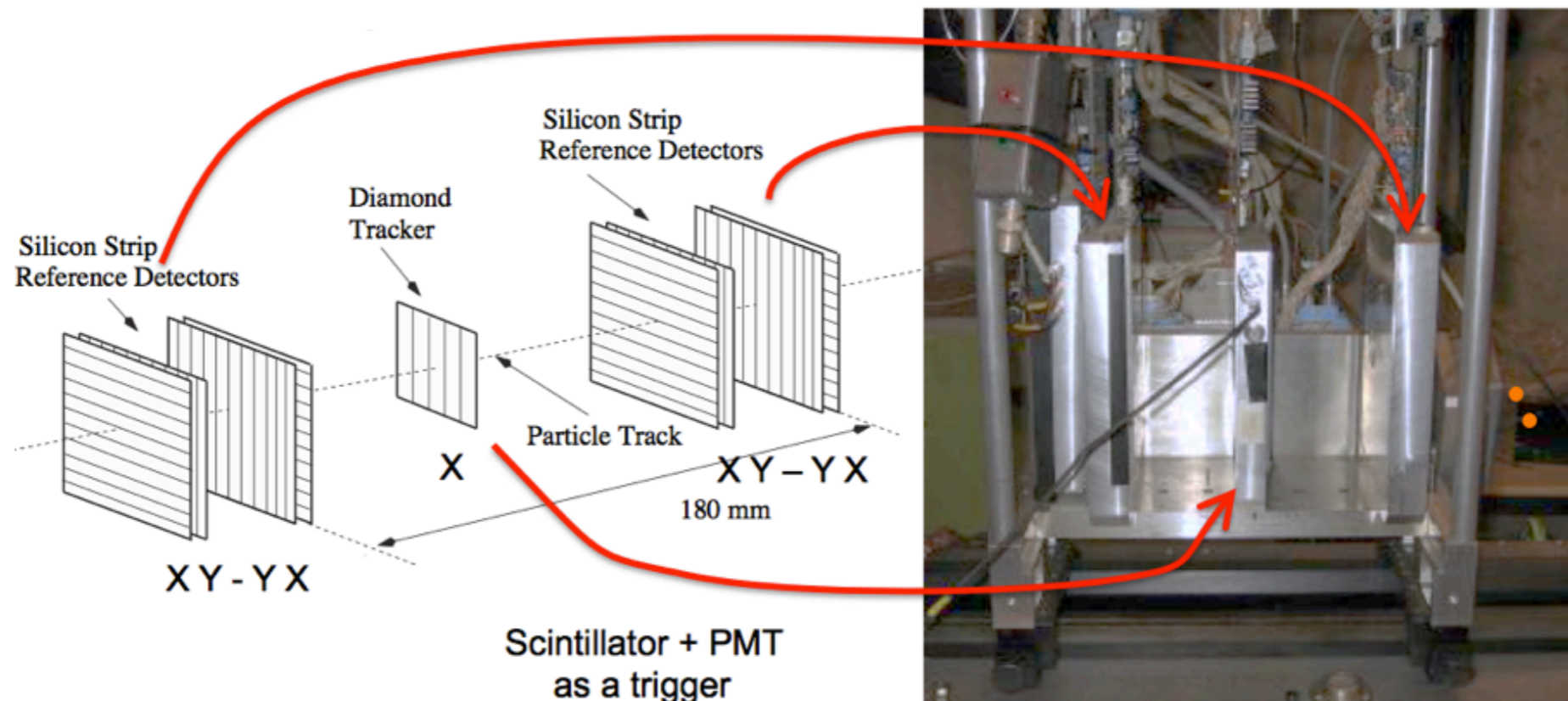
- Cr/Au electrodes
 - Connecting a row of laser drilled columns with one strip
 - readout strips interdigitated with bias strips
- Wire bonded to VA2 readout chip

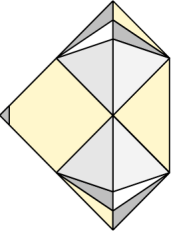




Beam test: setup

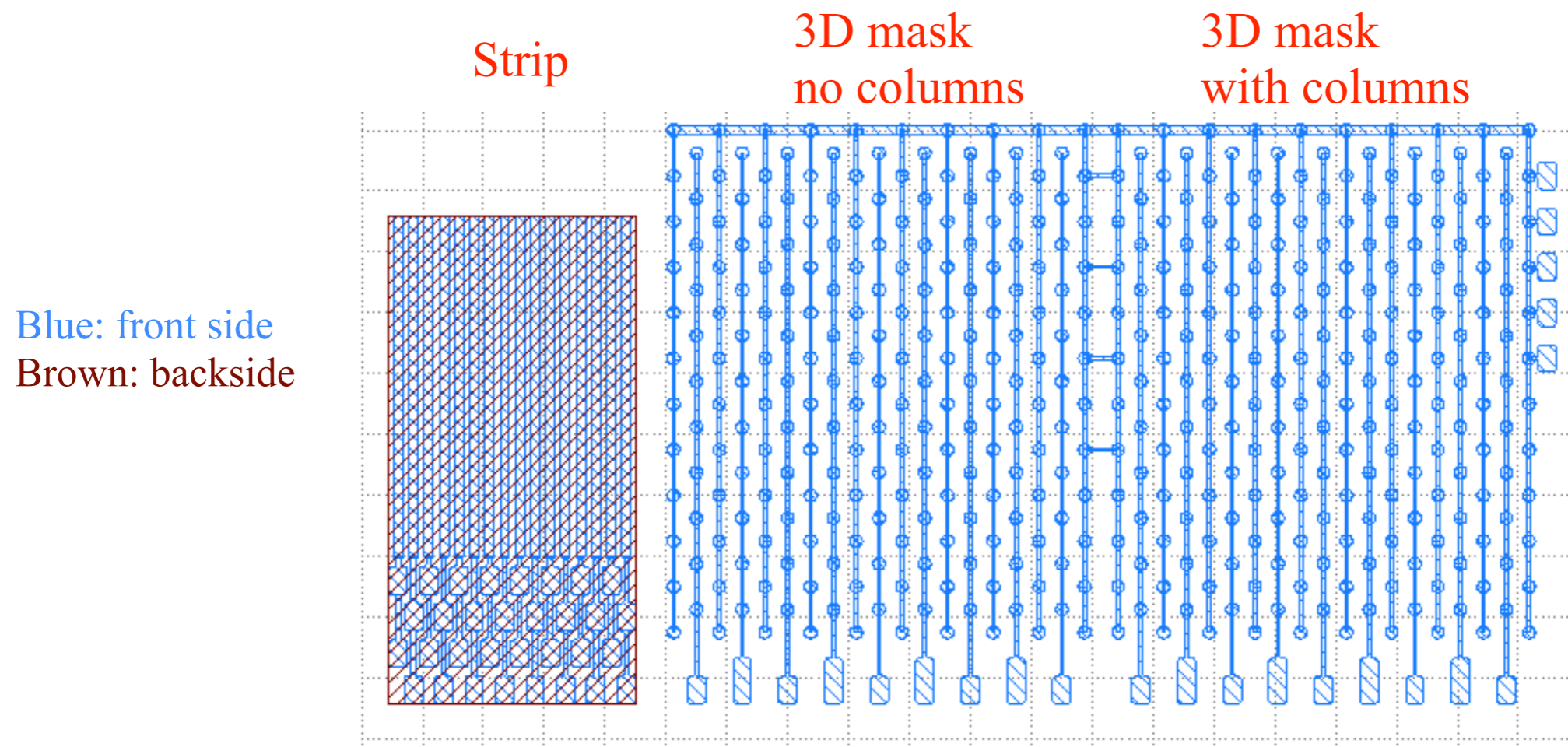
- CERN SPS H6 line
 - 120 GeV protons
- Strasbourg strip telescope
 - 4X, 4Y planes,
 - Resolution: a few μm
- Trigger - coincidence of 2 scintillators

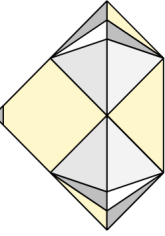




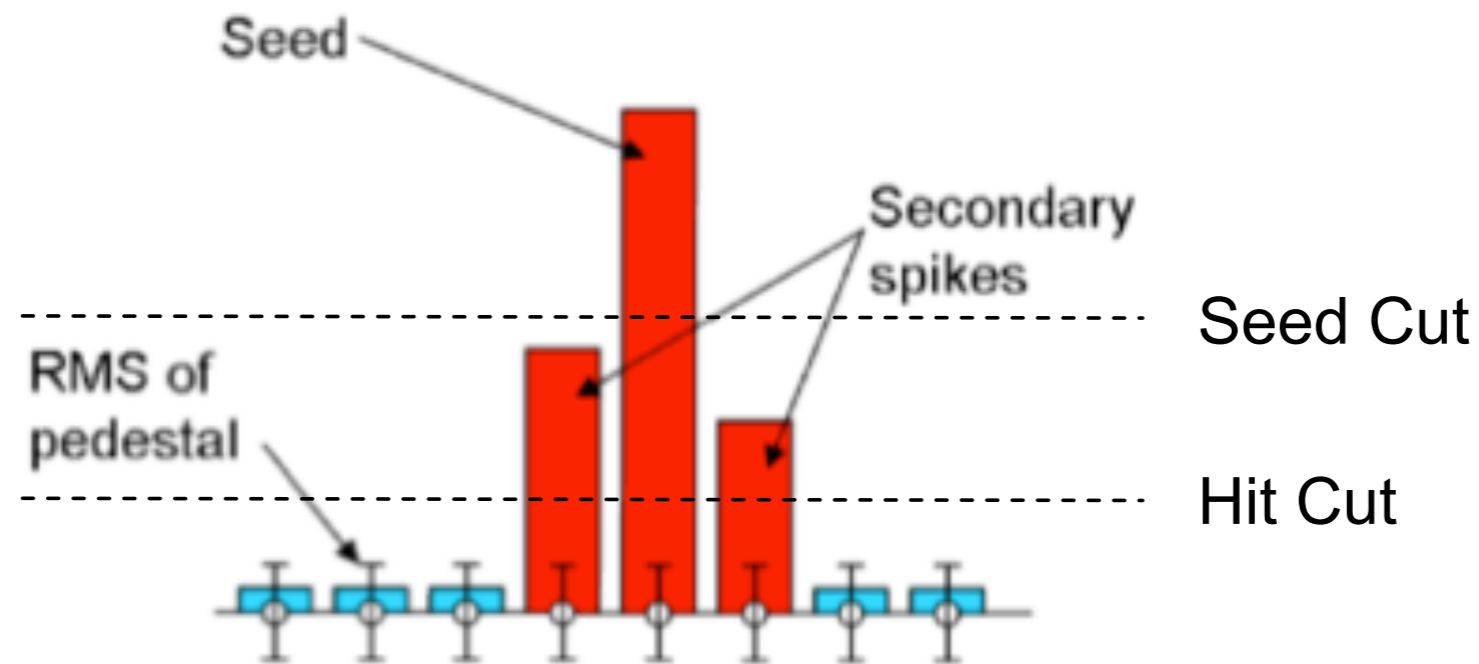
Beam test: DUT

- Single crystal CVD diamond
- Three test structures:
 - Strip detector as a reference to compare to with backplane (bias voltage)
 - Two 3D mask layouts (bias and readout from the same side)
 - Without machined columns (to understand influence of the electric field from surface metallization on charge collection efficiency)
 - With machined columns

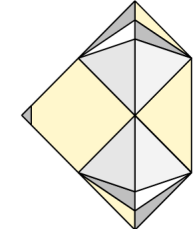




- pedestal subtraction
- clustering
 - seed cut 5σ
 - hit cut 3σ

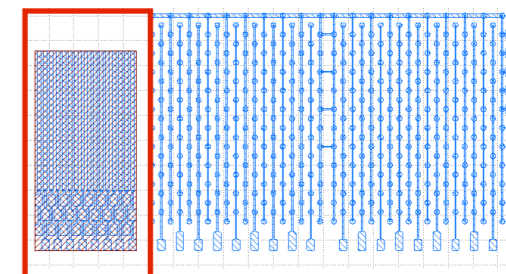


Beam test analysis: alignment

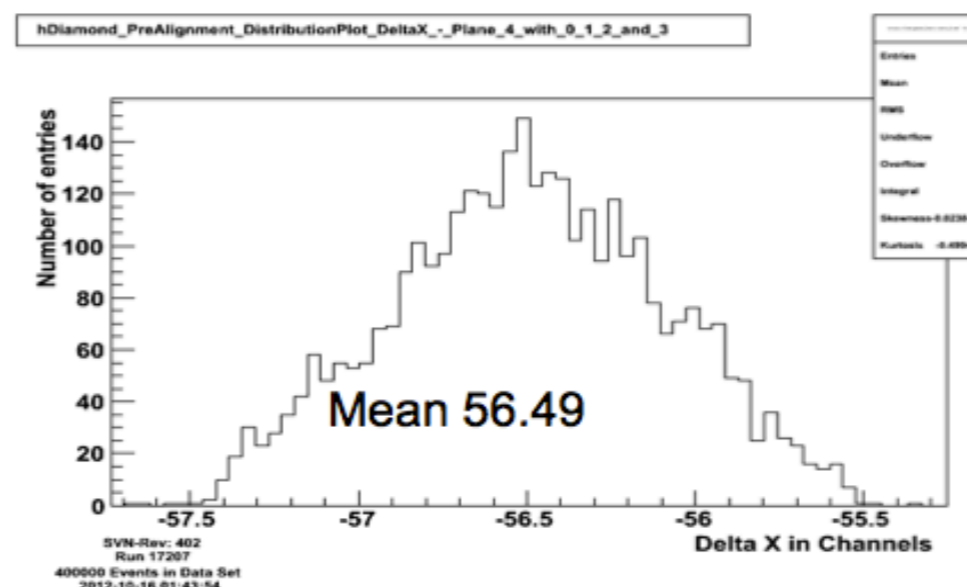
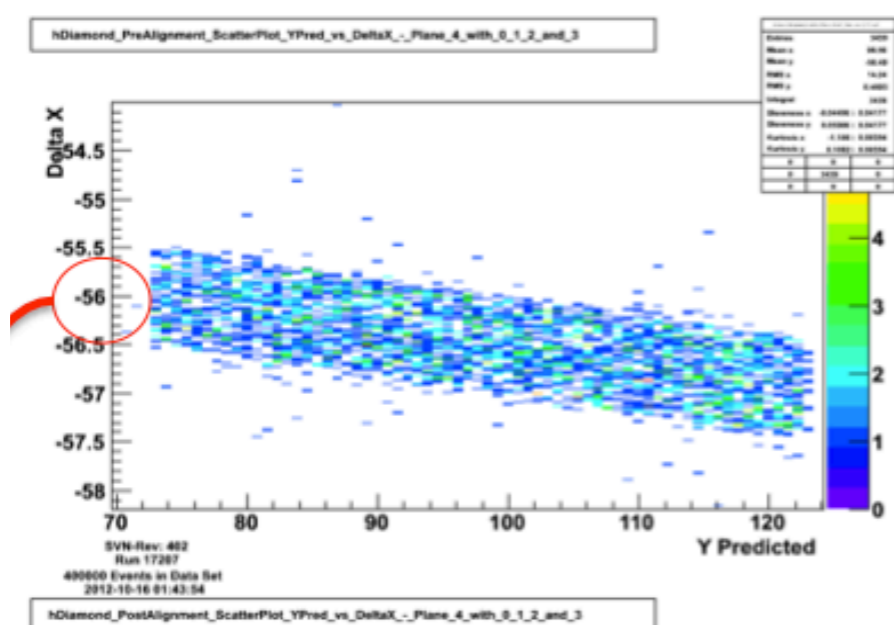


- Use the strip detector structure for precise alignment in X-direction

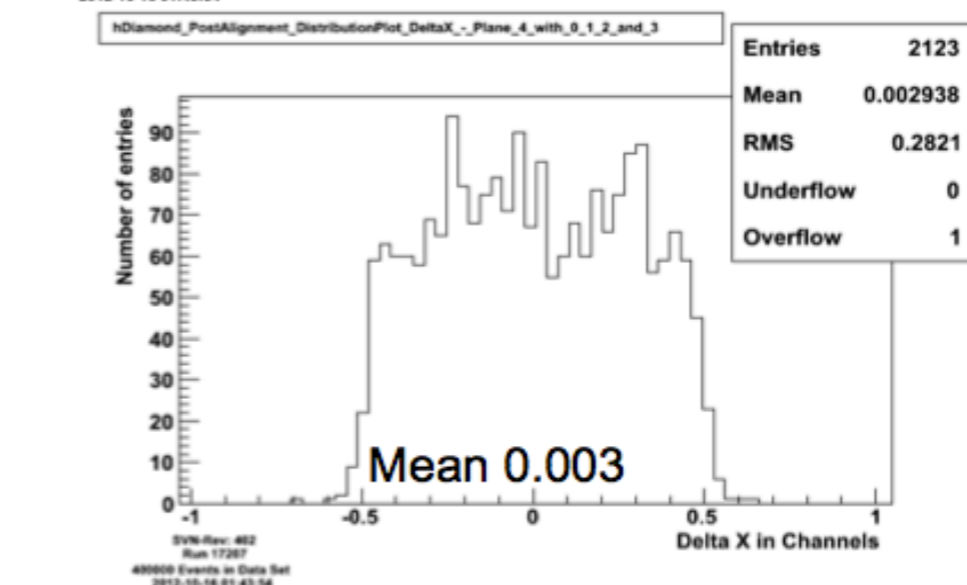
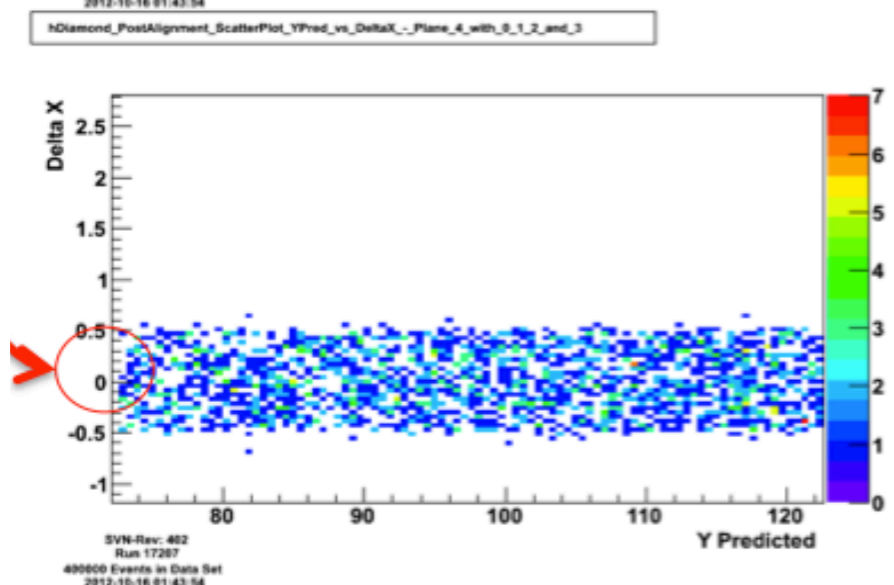
- Using strip with the highest signal



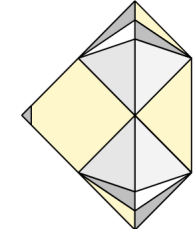
Before alignment



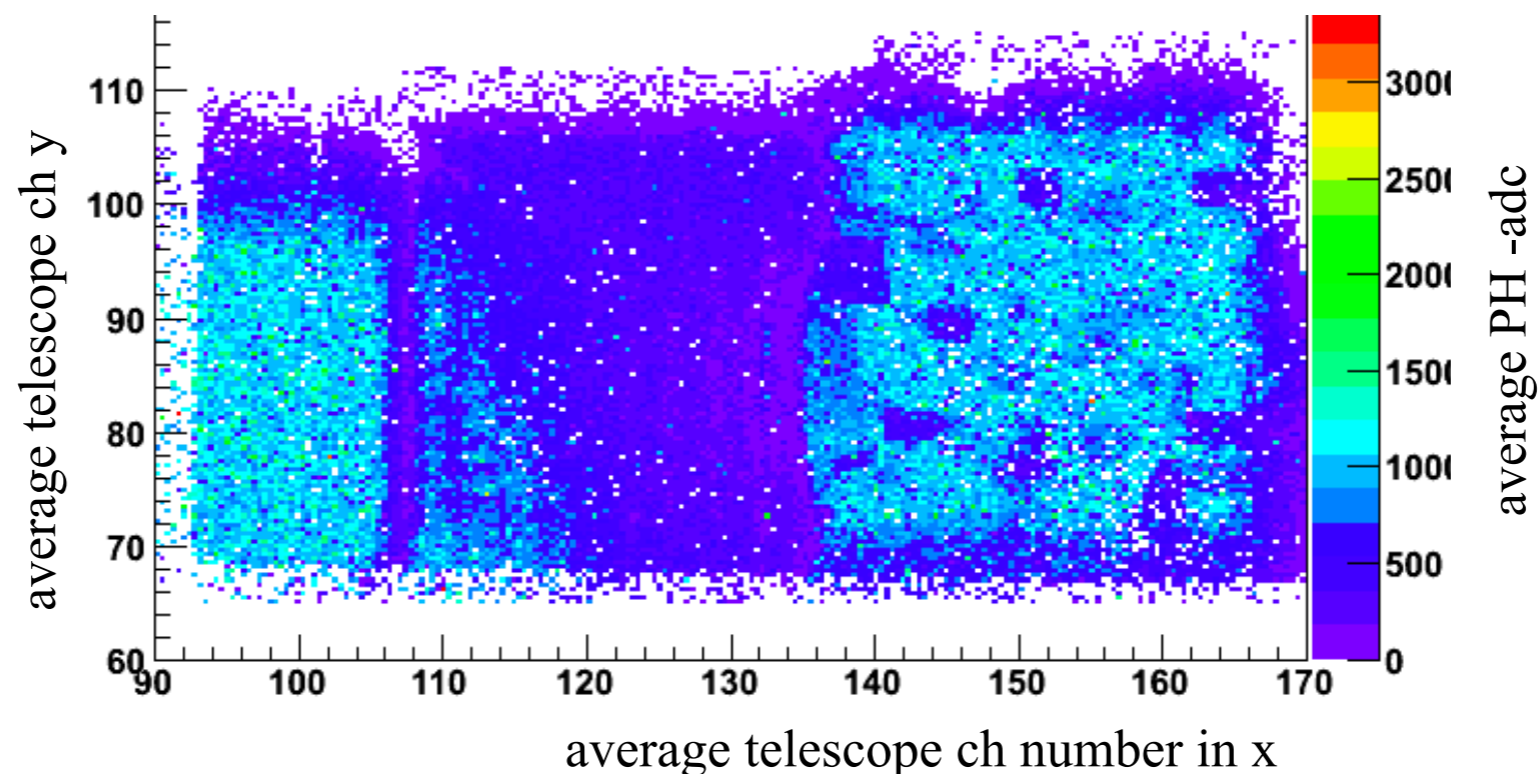
After alignment

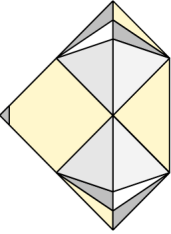


Beam test analysis: Fiducial regions

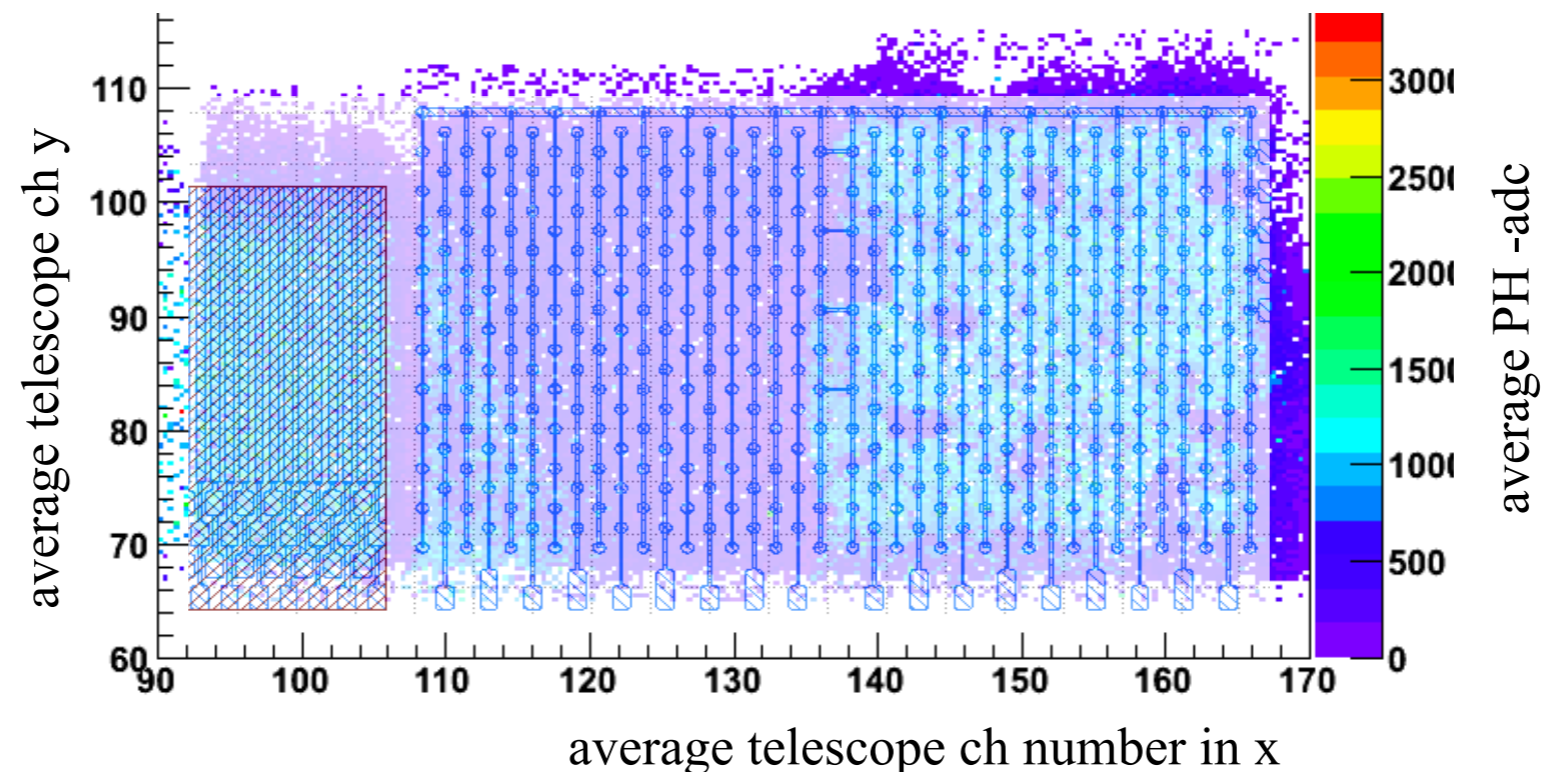


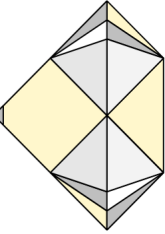
- Require one and only one cluster in each telescope plane
- Require at least one diamond cluster
- Plot PH in diamond for an average telescope position
- Overlay with a mask pattern
 - select a rough fiducial region



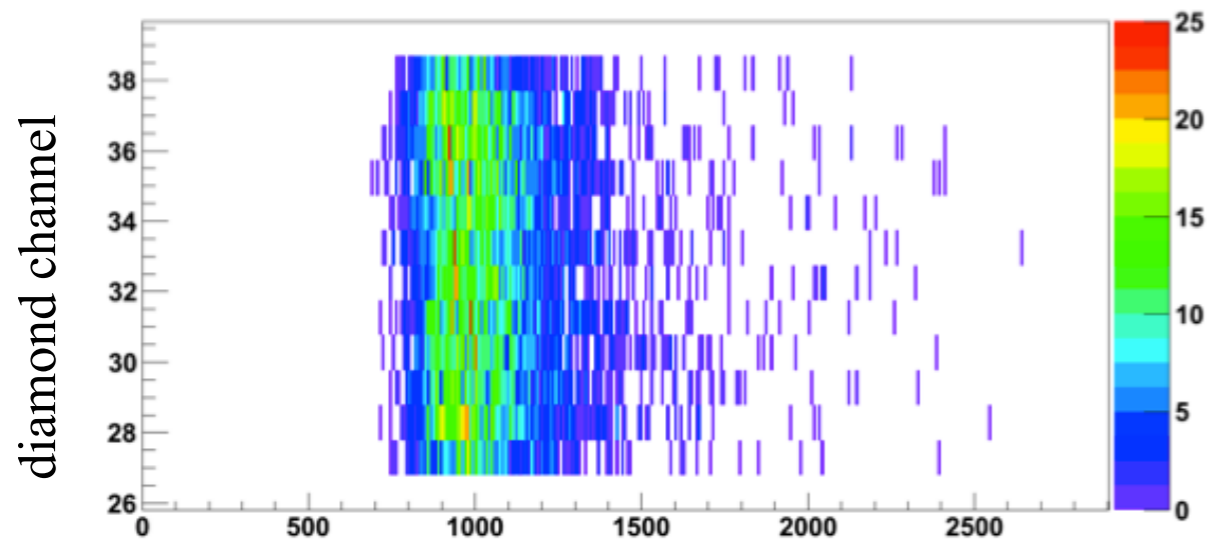
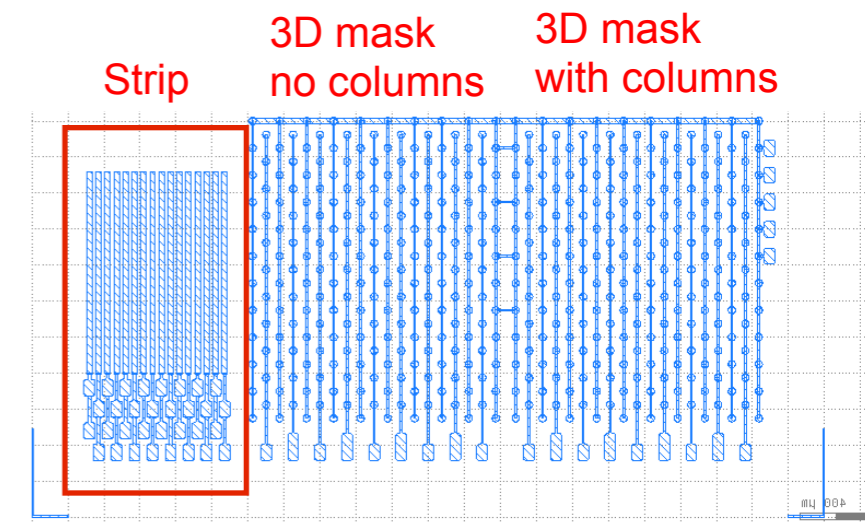


- Require one and only one cluster in each telescope plane
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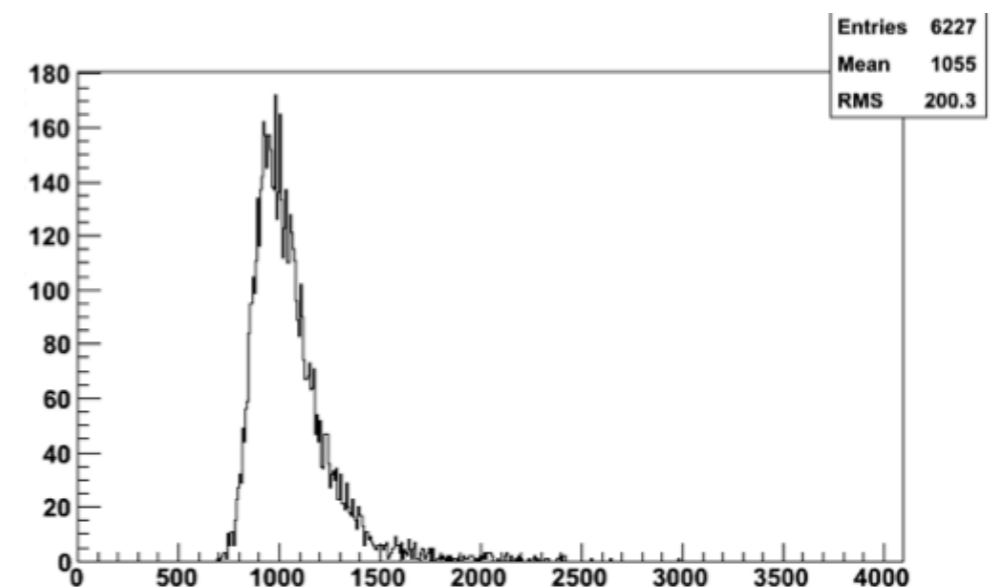




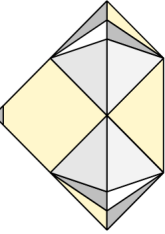
- Similar pulse height in every channel
- Landau distribution, MP @ ~ 1000



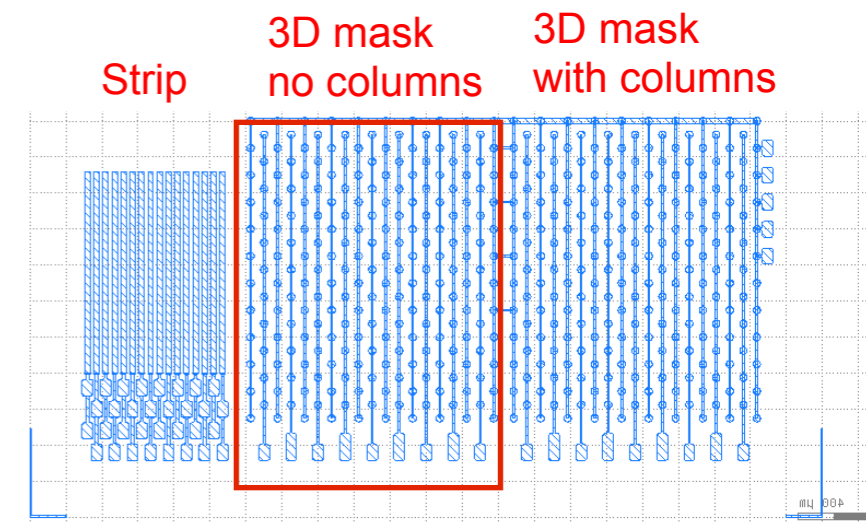
average cluster PH in adc counts



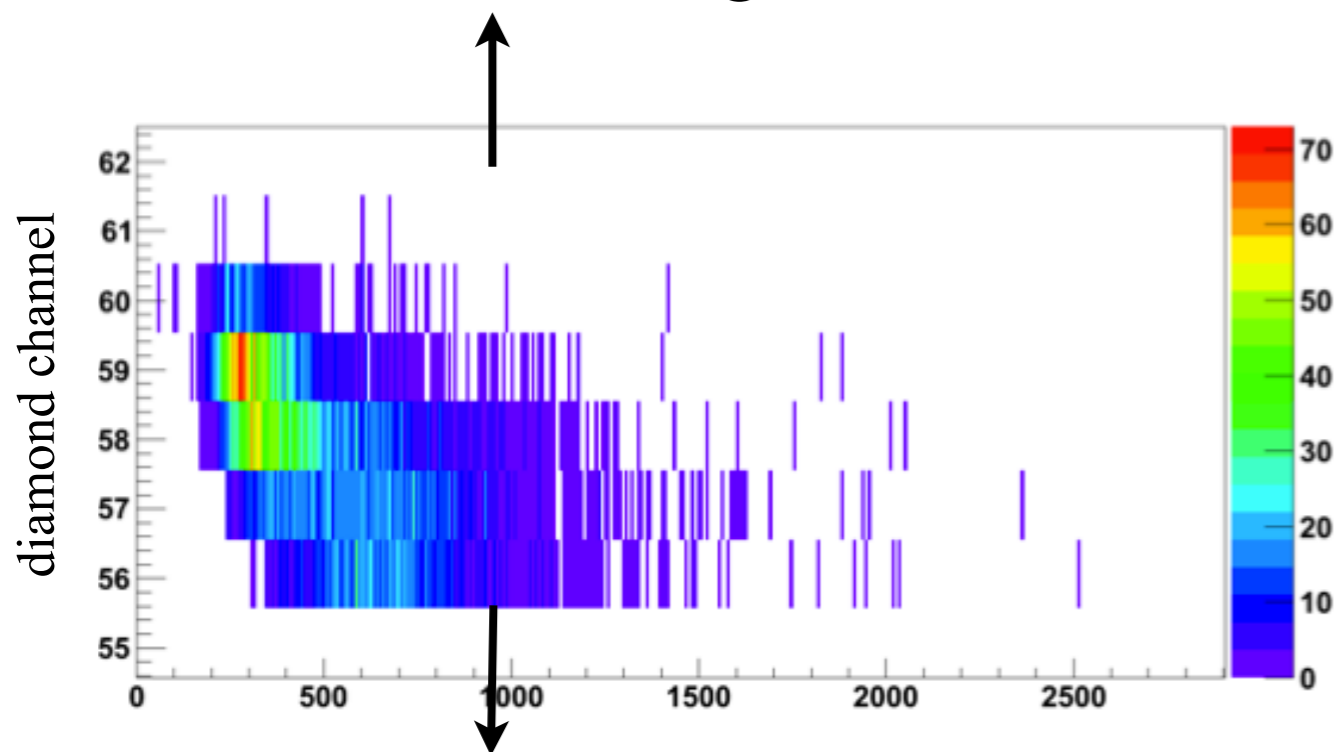
average cluster PH in adc counts



- Influence of strip structure (500V vs. 25V)
 - at lower channel numbers

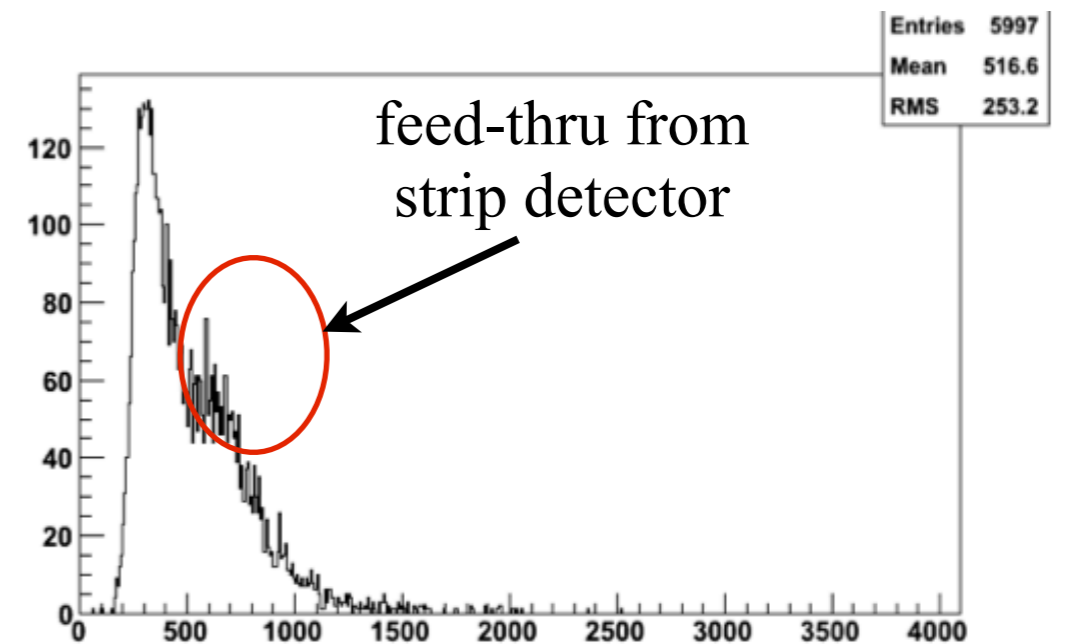


3D with columns @ 25 V

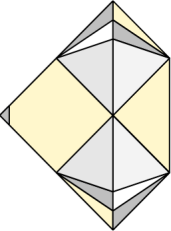


average cluster PH in adc counts

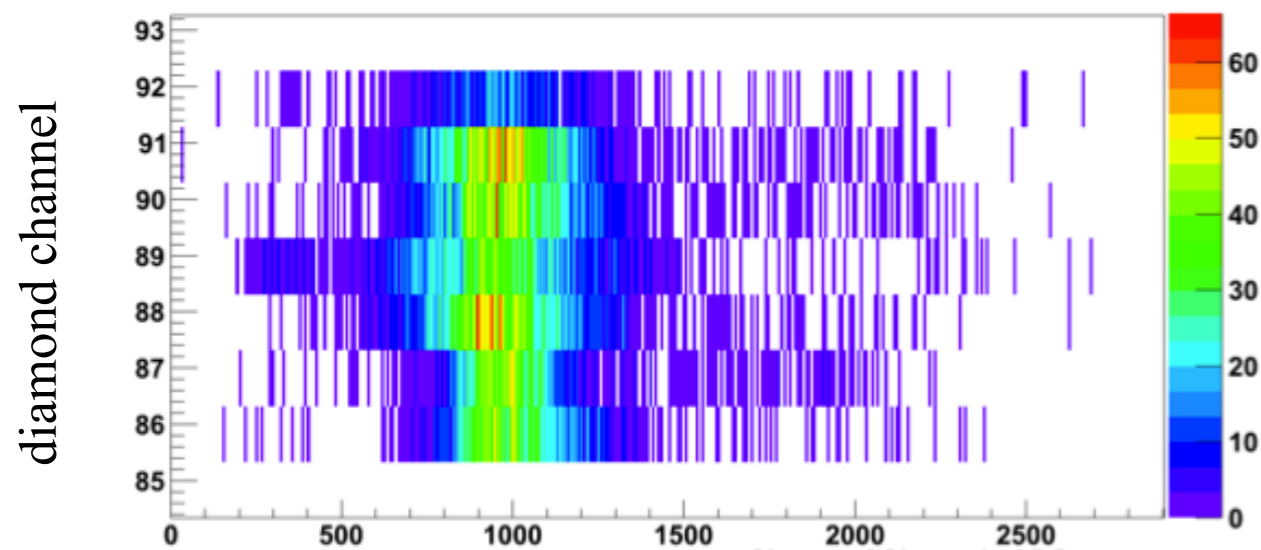
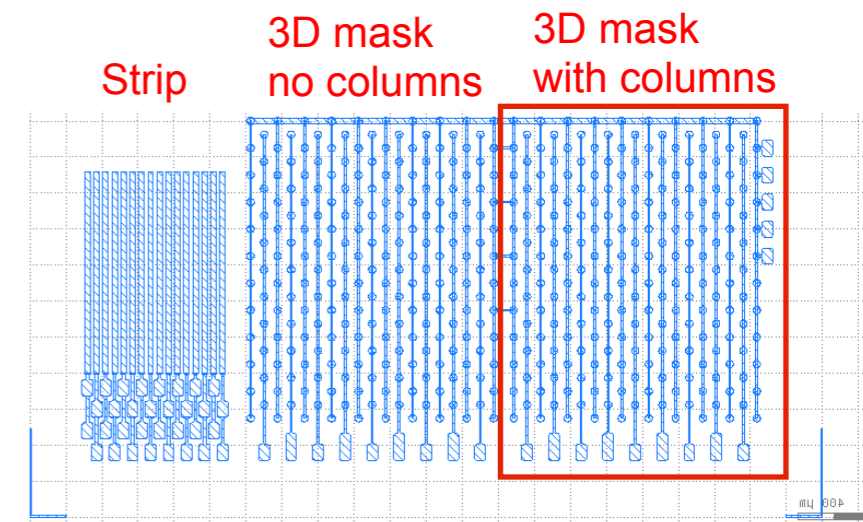
Strip detector @ 500 V



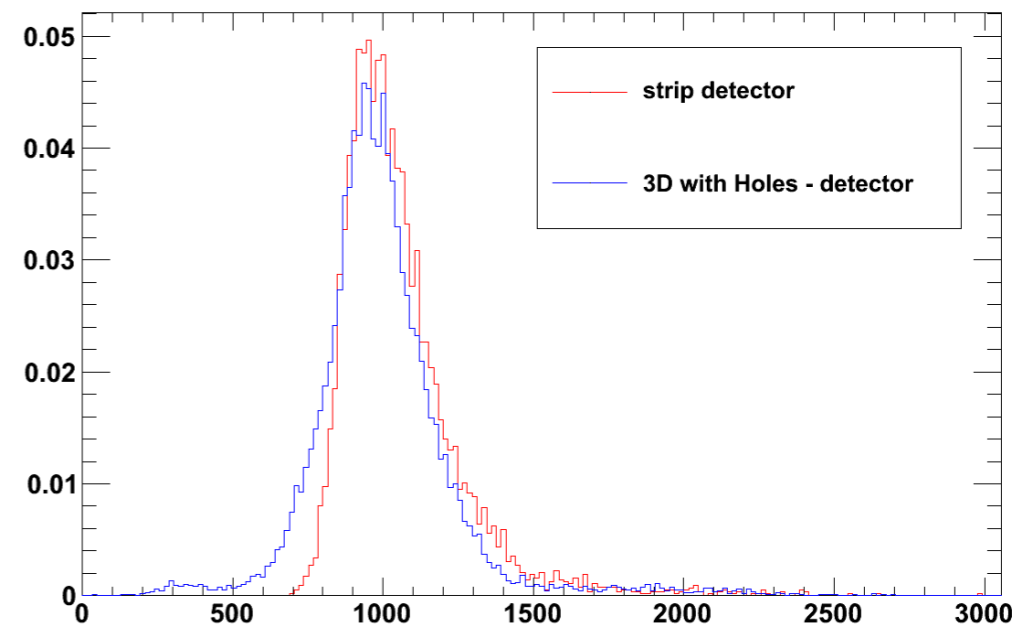
average cluster PH in adc counts



- Pulse heights for the whole 3D structure with conductive columns are plotted
 - no fiducial cuts within 3D structure
- Pulse heights are approximately the same for strip detector and 3D detector
 - 3D detector has only 25 V bias vs 500 V in strip detector!
- 3D detector has non-landauish tails
 - too low on the lower side and not high enough on the higher side

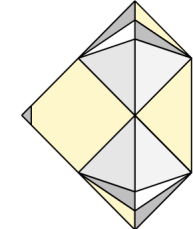


average cluster PH in adc counts



average cluster PH in adc counts

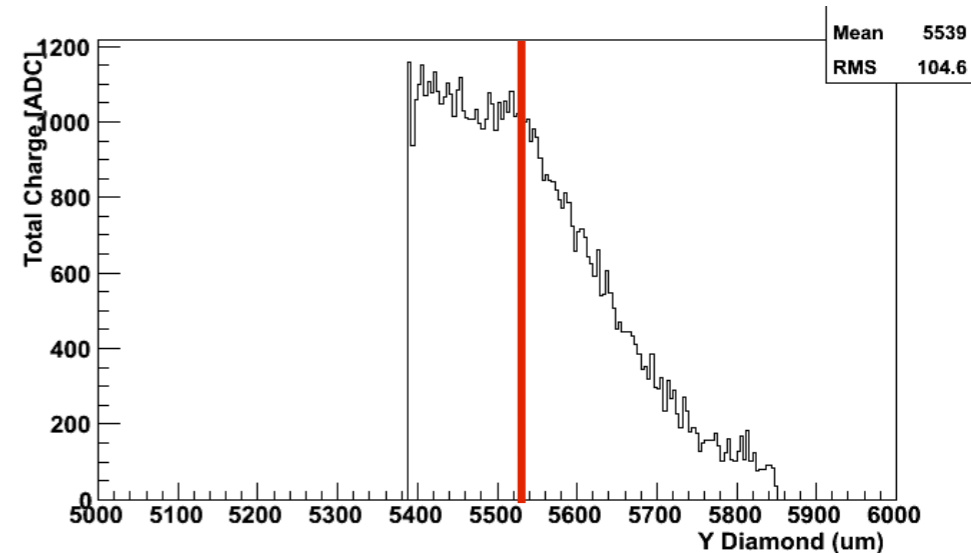
Y-alignment



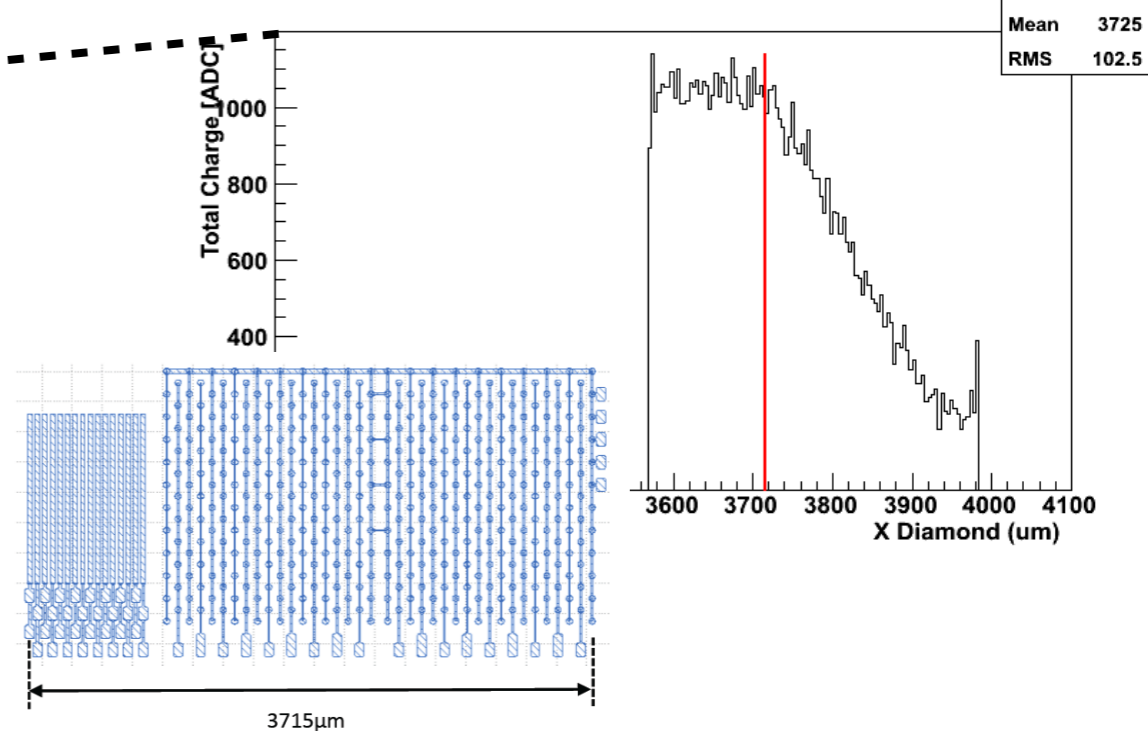
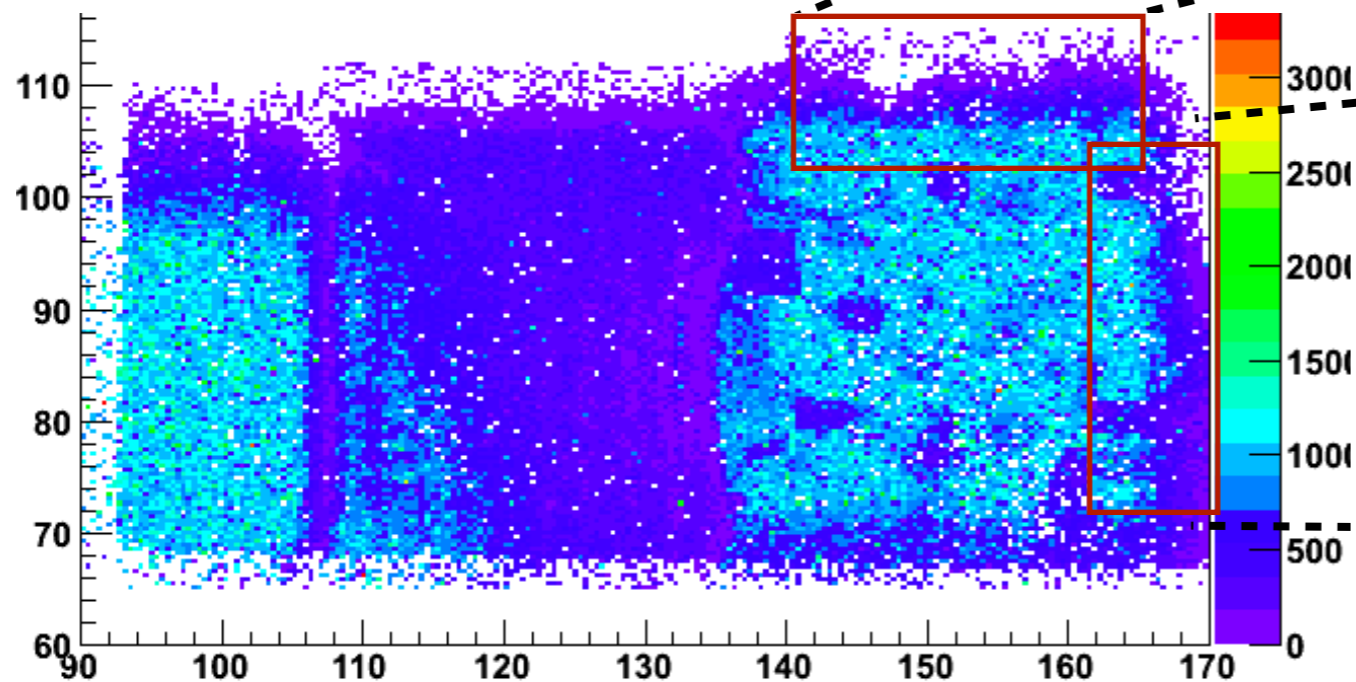
- Align using pulse height vs position distribution at the edges of the 3D detector

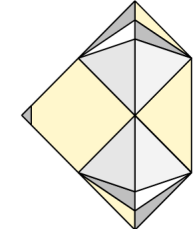
- plot pulse height vs X and pulse height vs Y distributions for the edges of the 3D detector
- predict the position of the right most edge in X direction based on geometry
- compare shapes of the distributions to measure the position of the top most edge of the 3D detector in Y direction

measure from the shape comparison

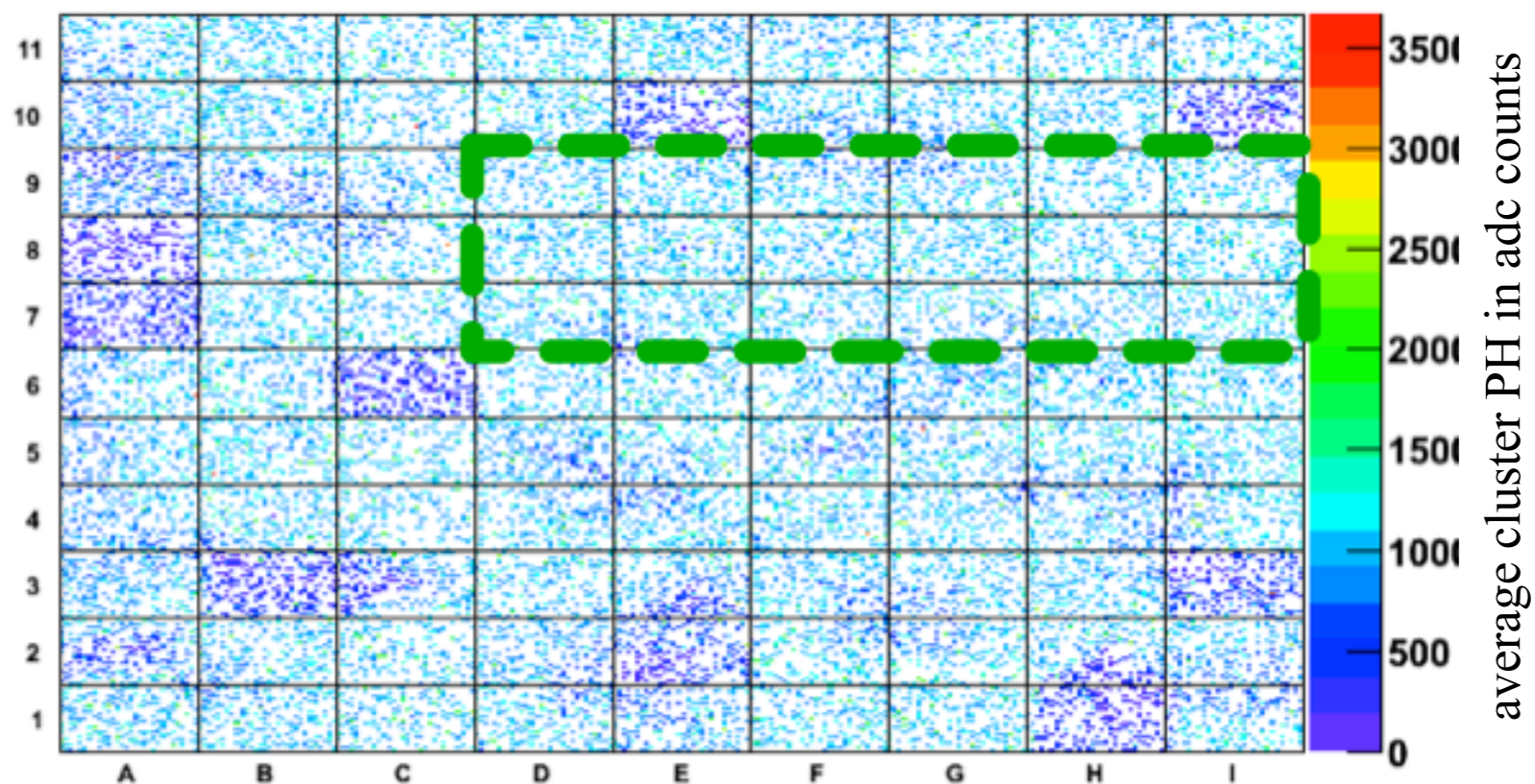


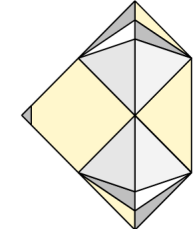
predicted based on the mask geometry



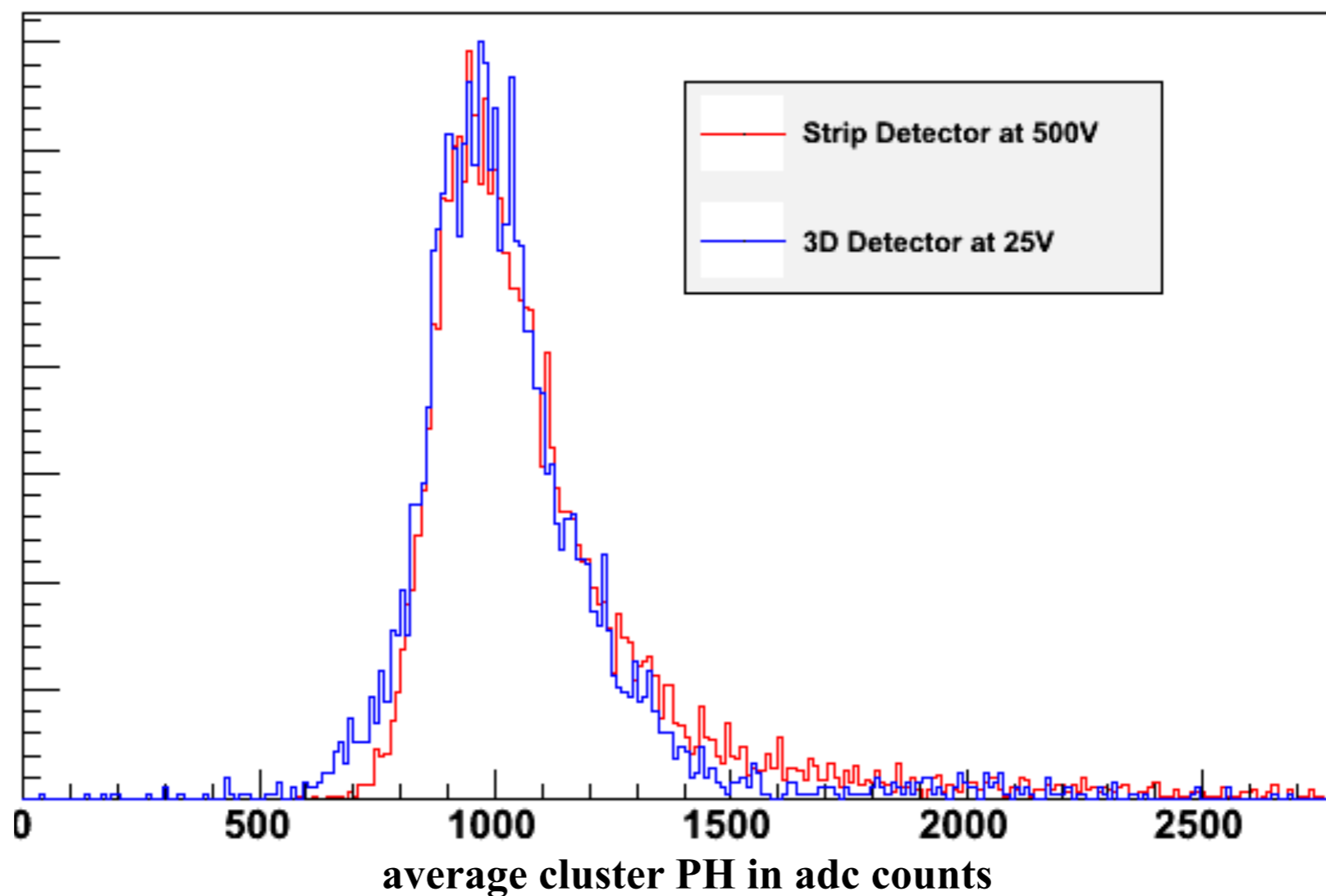


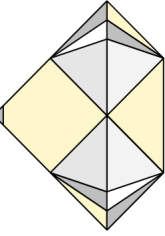
- Overlay with 3D cell structure
 - about 8 out of 99 cells have broken readout column
- select fiducial region of 18 cells





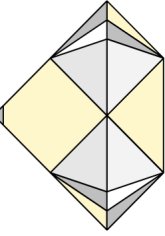
- better agreement of strip detector and 3D detector



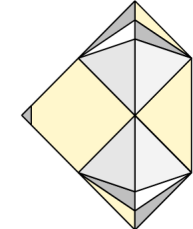


Conclusions

- RD42 explores the use of diamond tracking detector in high luminosity experiments
- One of the first diamond pixel tracking detector is being installed in a working experiment
 - DBM in ATLAS
 - PLT in CMS (pilot run)
- 3D structures show promise in diamonds
 - Full charge collection at lower voltage
- The production of 3D electrodes needs to be further optimized
 - more efficient “hole” drilling
- The radiation hardness of 3D detectors needs to be studied



Additional slides

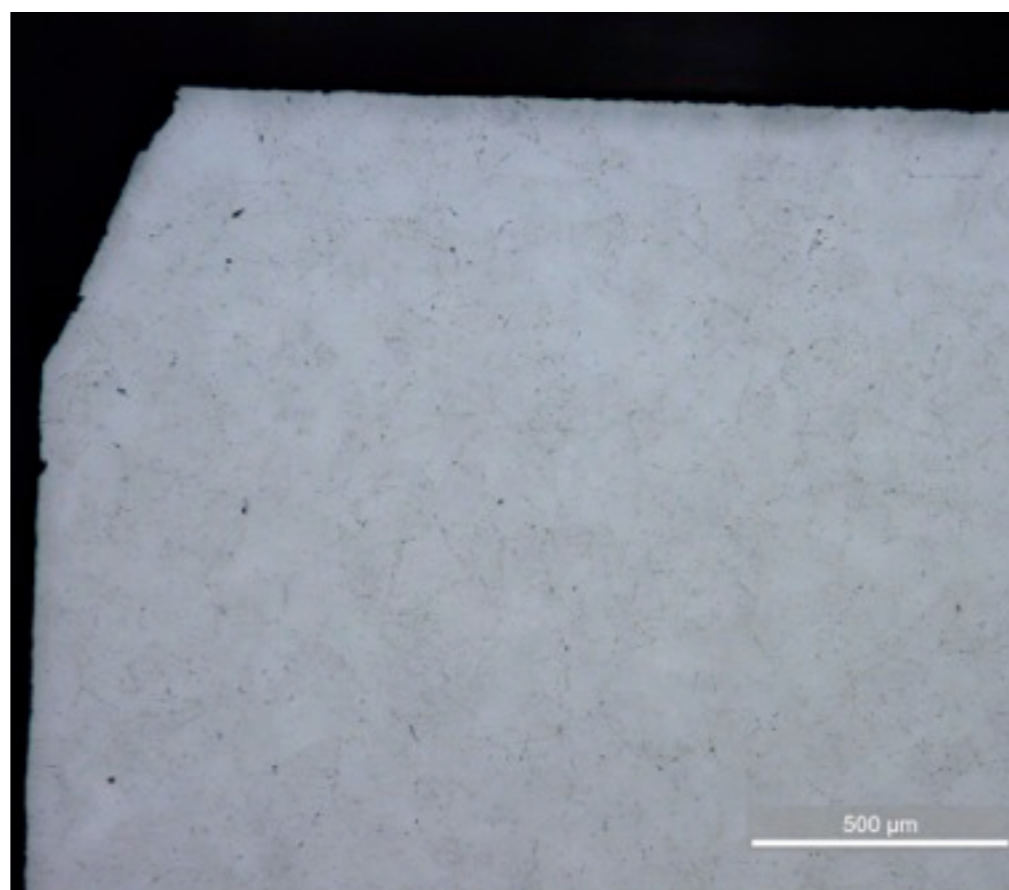
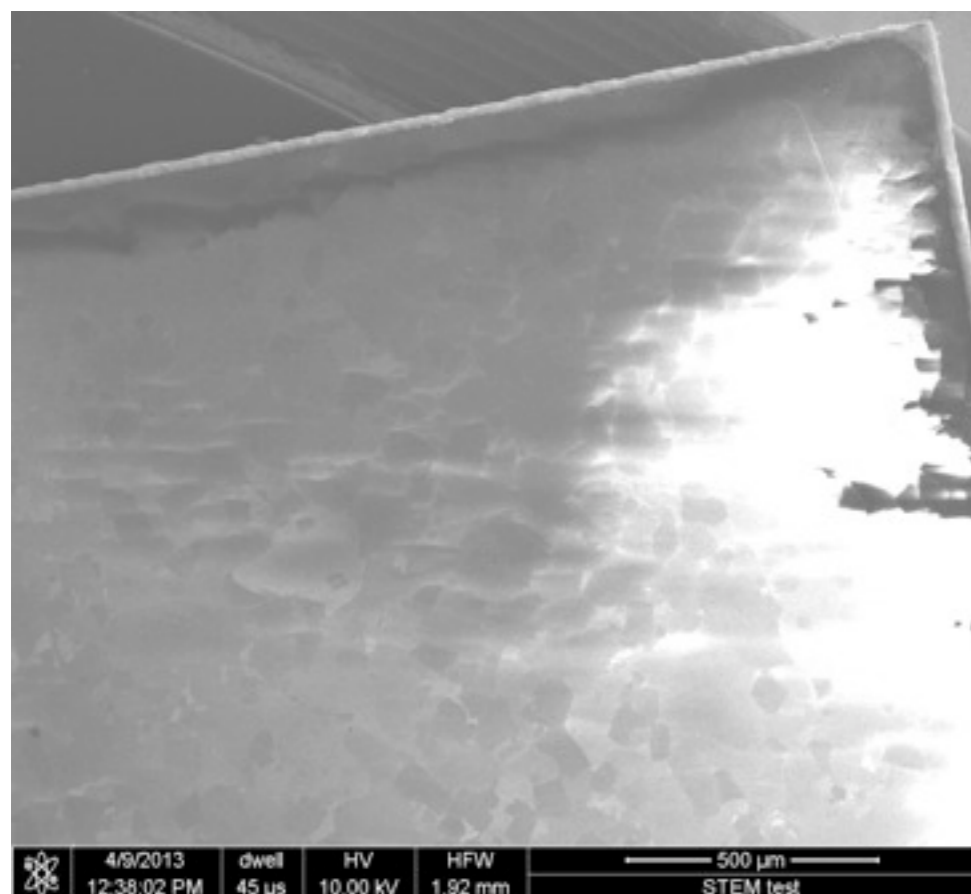


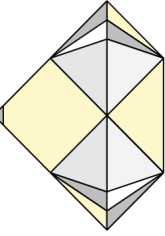
- As received diamond are cleaned with boiling acid(s).

Surface
Treatment

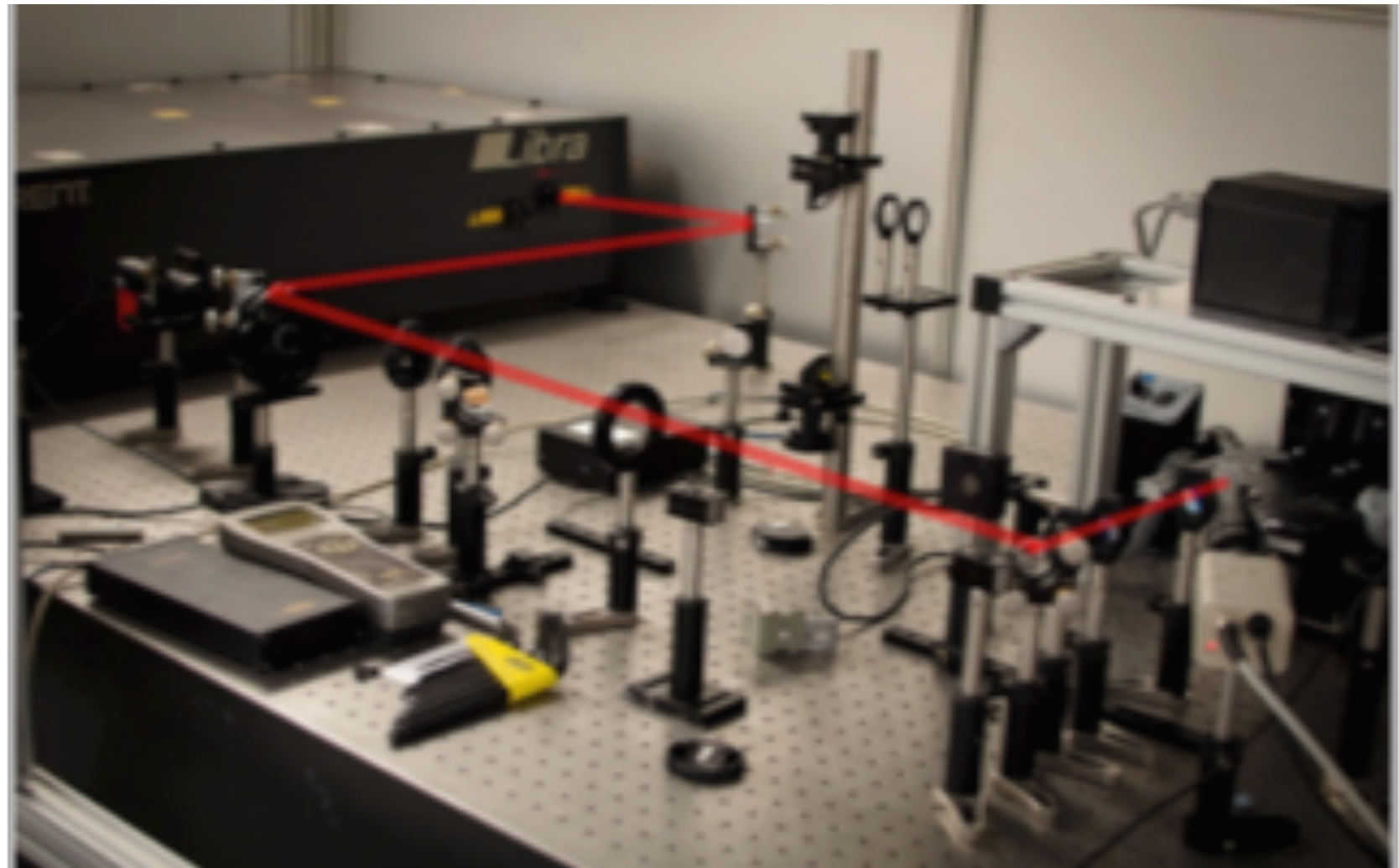
Column
Fabrication

Metallization

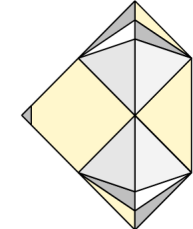




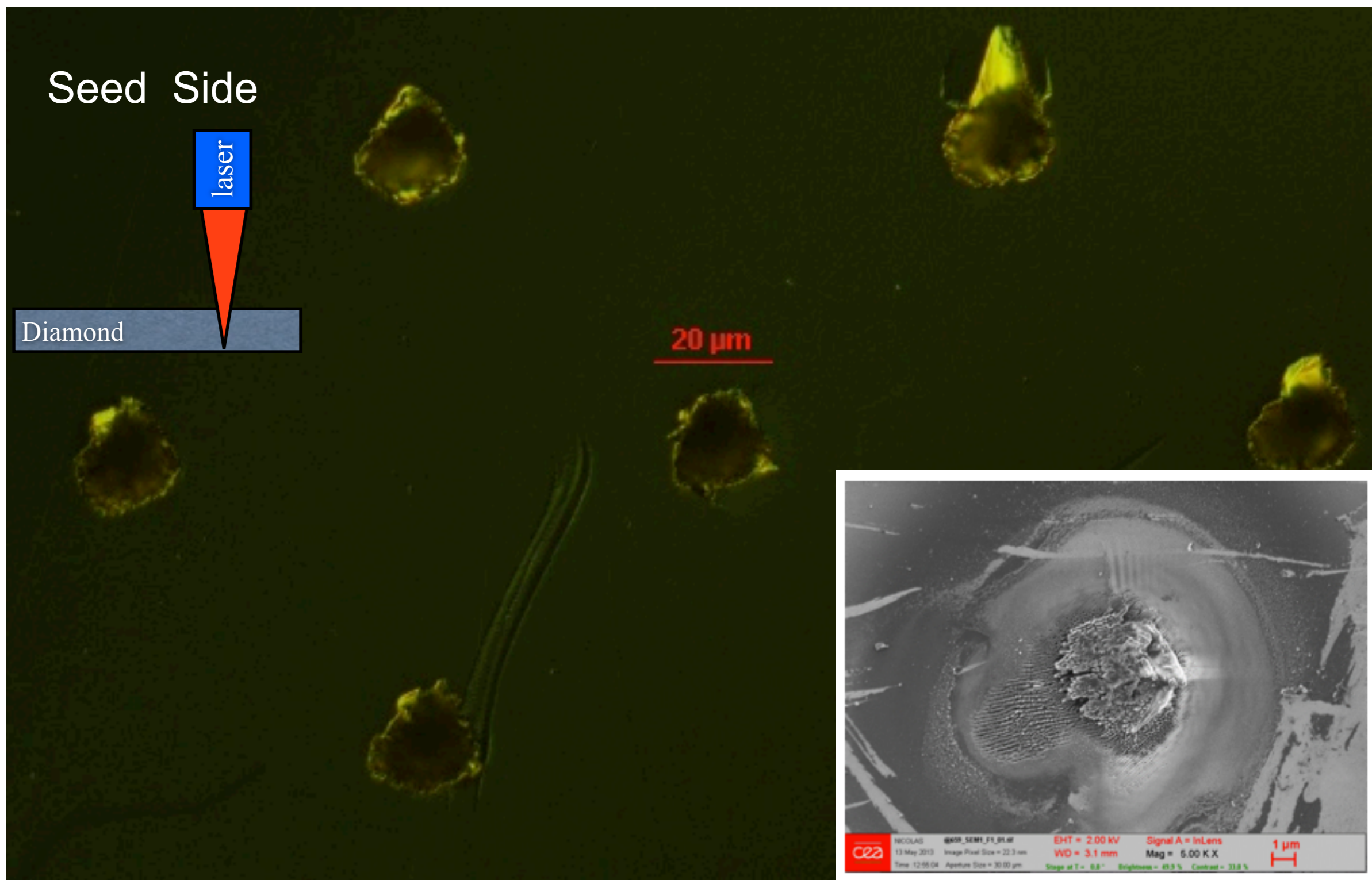
- Femto second laser
 - Wavelength = 800 nm
 - Repetition rate = 1kHz
 - Pulse duration = 100 fs
 - Spot size = 6 μm
 - Pulse Energy:
 - $E = 1 - 23 \mu\text{J/pulse}$
 - $\Phi = 1 - 30 \text{ J/cm}^2$



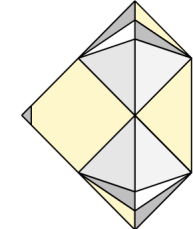
Column drilling



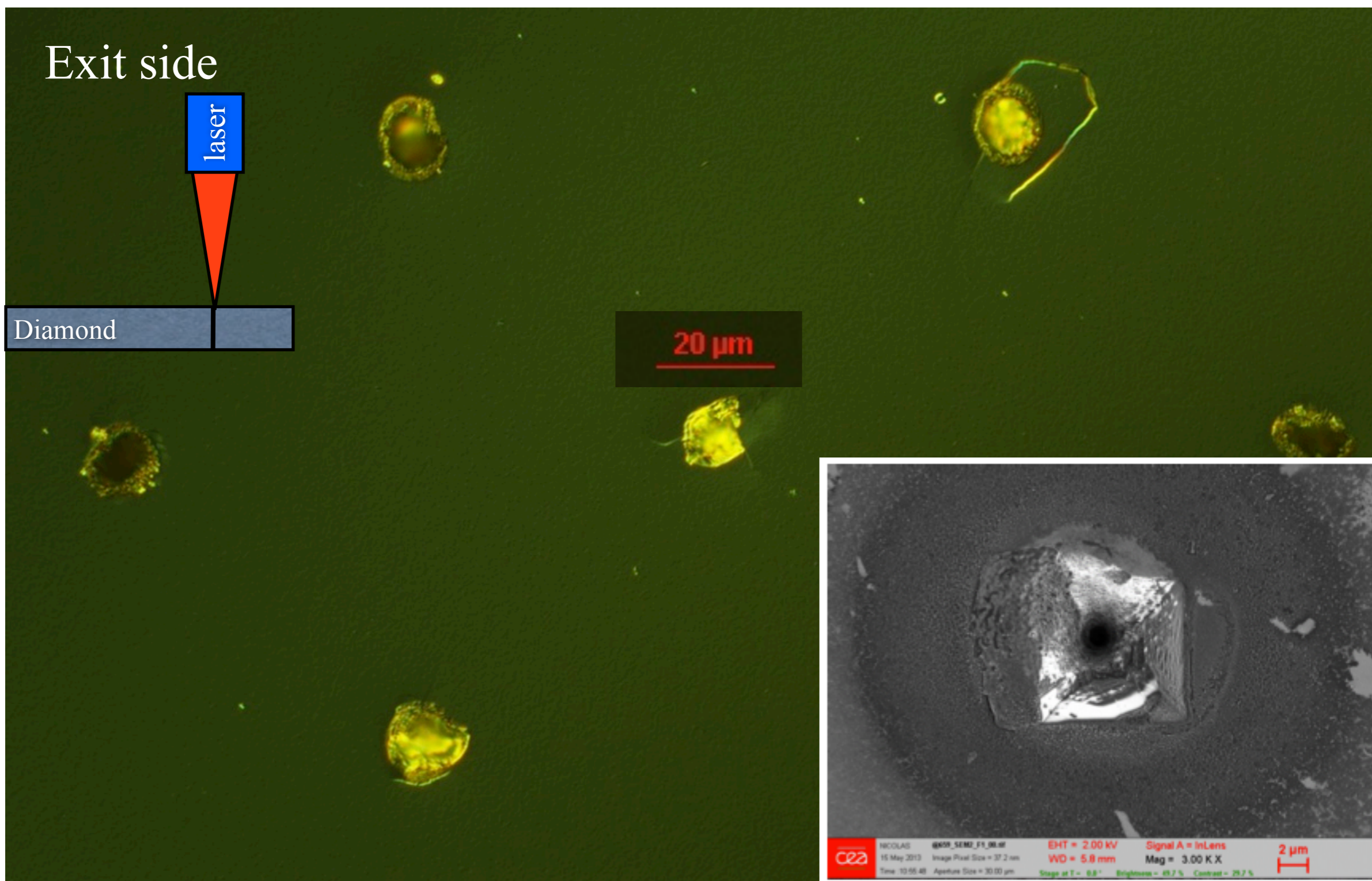
- extra material forms small bumps on the seed side

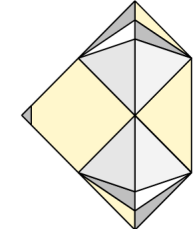


Column drilling

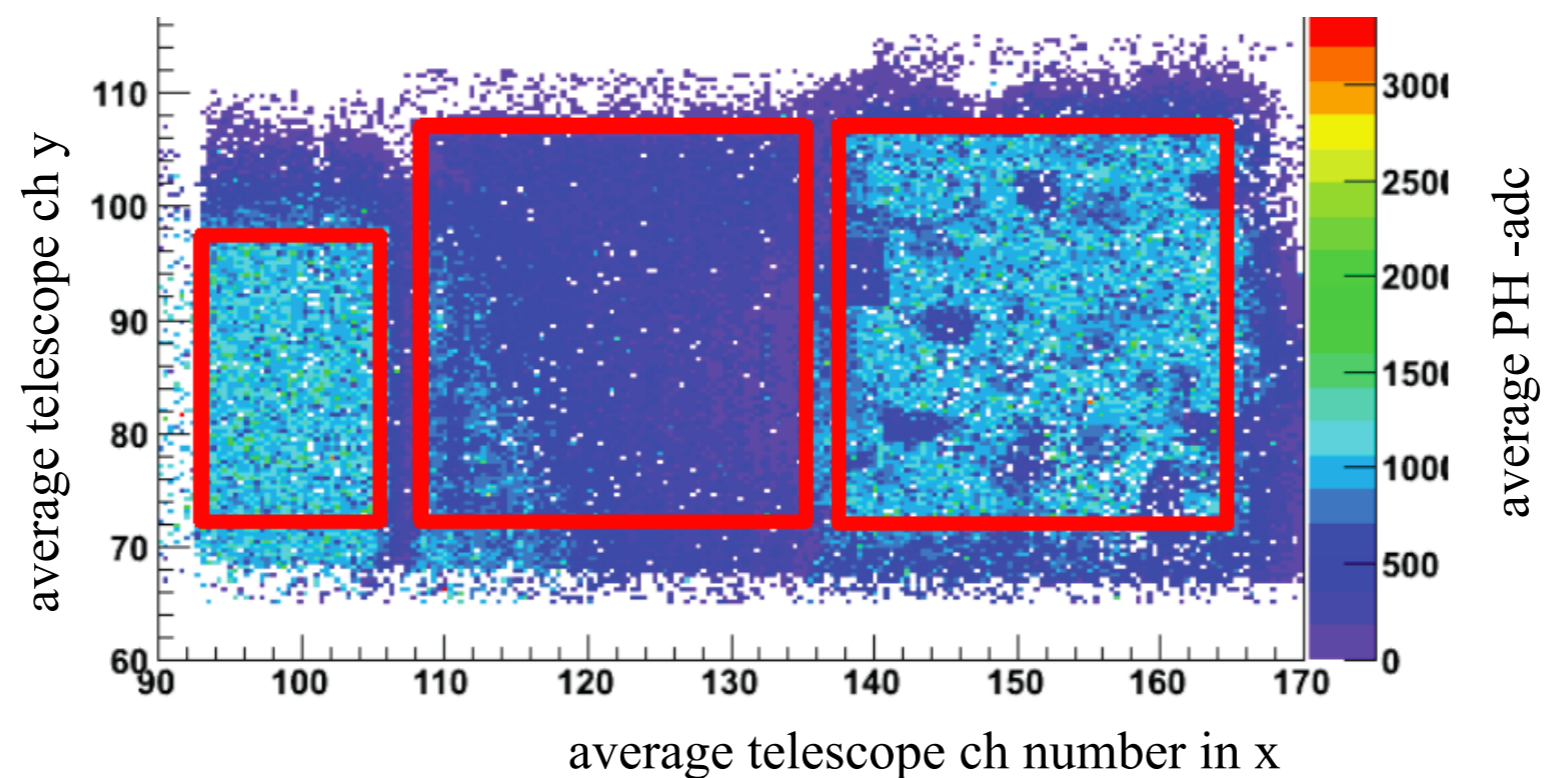


- On the exit side the “craters” are formed





- Fiducial regions for the three different patterns



First DBM modules

